



**CEATEC**<sup>®</sup>  
TOWARD SOCIETY 5.0

**2024**

Innovation  
for All **25<sup>th</sup>**

## **Exhibition Report**

**CEATEC 2024**  
**October 15(Tue)-18(Fri), 2024**  
**Makuhari Messe**

Organizer

**JEITA** Japan Electronics and Information  
Technology Industries Association

Co-sponsors

**CIAJ** Communications and Information  
Network Association of Japan

 Software Association of Japan

# CEATEC 2024 Topics

## Digest

CEATEC 2024 was held as a "Comprehensive Exhibition of Digital Innovation," a place for co-creation through the "CEATEC Experience," which refers to "seeing" exhibits, "listening" to conferences, "feeling" and "thinking" about future society, and "moving" toward co-creation.

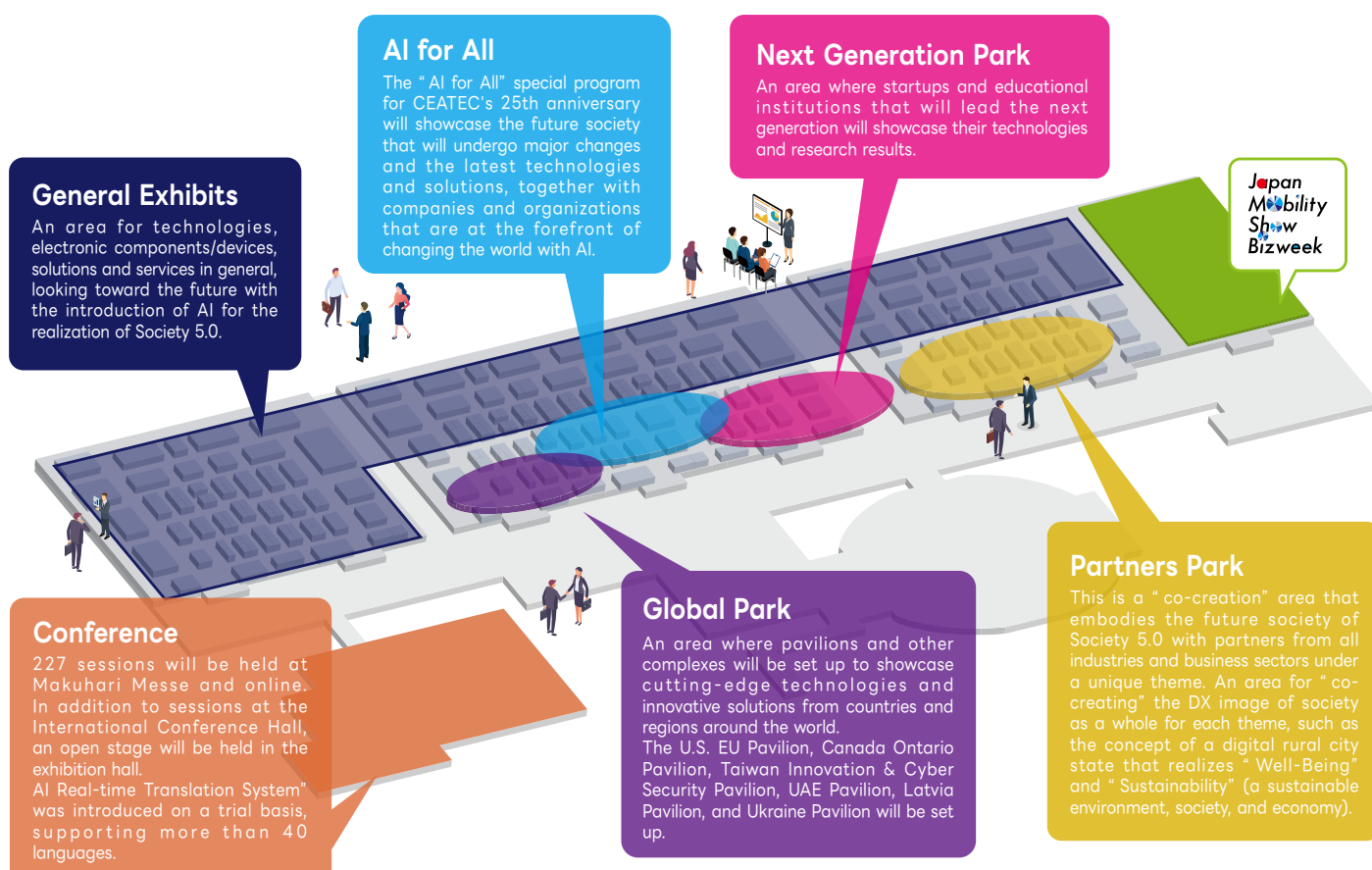
CEATEC 2024 was held at Makuhari Messe from October 15 (Tuesday) to 18 (Friday), 2024, marking the 25th year of the exhibition, and was a four-day event that broadened the scope of industry and embodied this year's theme, "Innovation for All". In addition, the 25th anniversary special program, "AI for All," was held with companies and organizations that are at the forefront of changing the world through AI, presenting the future society that will undergo major changes and the latest technologies and solutions. In the stage program, leading Japanese research institutes and companies, as well as overseas companies specializing in AI, gathered to present the forefront of AI technology.

The exhibition attracted 808 exhibitors (including 158 overseas exhibitors from 25 countries/regions) and 112,014 registered visitors during the show period. In addition, 1,087 press visited the show during the exhibition period, and the event was broadcast daily by domestic and international online news, television, newspapers, and other media.

In addition, the event was co-located for the first time with the JAPAN MOBILITY SHOW BIZWEEK organized by the Japan Automobile Manufacturers Association (JAMA), creating an opportunity for co-creation with automobile-related industries.

The morning of October 15 (Tuesday), the first day of the show, was designated as "premium time," when the show was open only to invited guests, including members of the press and important customers of exhibitors. Also, the opening reception was held at the Palace Hotel Tokyo in the evening of the same day (Oct 15th), with opening remarks by Kazuhiro Tsuga, Chairman of the Japan Electronics and Information Technology Industries Association (JEITA), the organizer of the exhibition, followed by a video message from Shigeru Ishiba, Prime Minister in Japan. Mr. Masaaki Taira who is Minister of Digital Transformation, Mr. Ryosuke Kouzuki who is Vice minister of Economy, Trade and Industry, Mr. Shigeki Baba who is Vice minister of Internal Affairs and Communications, and Mr. Toshiaki Higashihara, who is Vice Chairperson of Japan Business Federation (Keidanren), Mr. Masanori Katayama who is Chairperson of Japan Automobile Manufacturers Association, Inc (JAMA). The opening reception was attended by approximately 700 people, including executives from exhibiting companies, foreign embassy officials, and government officials, and was a great opportunity for participants to get to know each other. In addition, the Minister of State and Vice Minister of Economy, Trade and Industry presented the CEATEC AWARD 2024 Minister's Awards with certificates and plaques, and set up exhibition booths for the Minister's Awards and 25th Anniversary Special Awards.

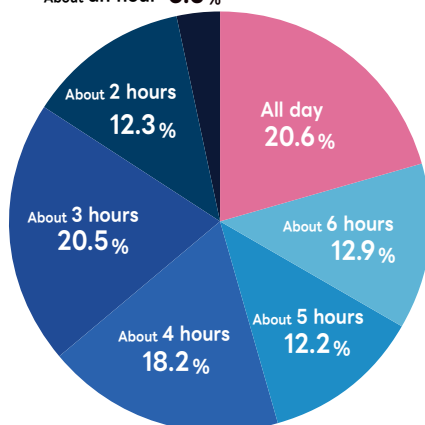
## Exhibition Area



## Visitors Profile

Number of  
Visitors**112,014**Automotive  
/ Transportation equipment **12,000+**Manufacturing, machinery,  
precision equipment **12,000+**Electronic Components  
/ Devices **7,400+**Information processing  
and service **5,000+**Information  
and Communication Equipment **4,000+**Software **3,500+**Government  
and public agencies **3,500+**Students **8,000+**

## Visiting Time in Exhibition

About an hour **3.3%**

## CONFERENCE

Number of  
CONFERENCE**227**Number  
of Speakers**397**

Total of Audience

**30,947**

## Exhibitors Profile

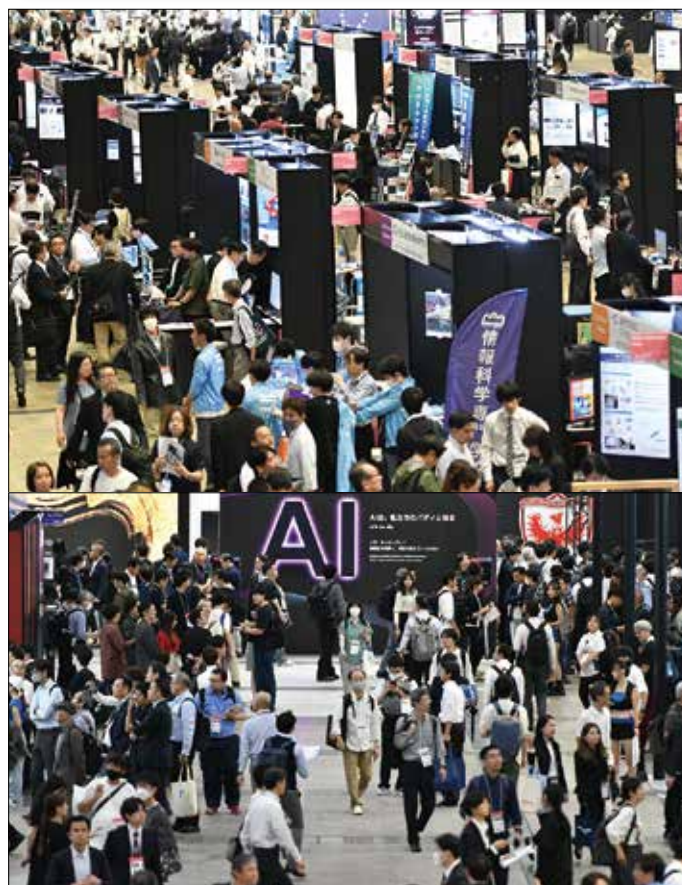
Number of Exhibitors

**808**Startup & University  
and Research Organizations**188** companies  
/ organizations

International exhibitors

**158** companies  
/ organizations from **25** countries  
/ regions

Satisfaction with CEATEC 2024 (overall rating)

**84.7%** of exhibitors are **satisfied**

## PRESS Profile

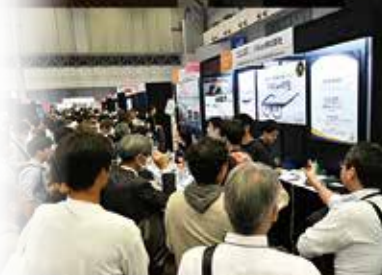
Registered Press:

**1,087** Press membersNewspaper  
in Japan:**242**Broadcasts in Japan **39** programs**2** hours, **29** minutes, **39** seconds  
in totalX  
Impressions**5,400,000**Facebook  
Impressions**4,609,495**LinkedIn  
Impressions**1,031,522**



## Event Overview

<b>Name</b>	CEATEC 2024 Combined Exhibition of Advanced Technologies
<b>Outline</b>	Aiming to realize "Society 5.0" that balances economic development with solutions to social issues, We will bring together people, technology, and information from all industries and business sectors to envision the future through "co-creation".
<b>Dates</b>	October 15 (Tue) - 18 (Fri), 2024 <b>■ Premium Time:</b> October 15 (Tue) 10:00AM-12:00PM *Premium Time is open only to invited guests and press. <b>■ General Admission (Opening Hours):</b> October 15 (Tue) 12:00-5:00PM, October 16 (Wed) - October 18 (Fri) 10:00AM-5:00PM
<b>Venue</b>	Makuhari Messe (2-1 Nakase, Mihama-ku, Chiba City, Chiba Prefecture)
<b>Admission</b>	Free of charge (registered admission required for all visitors)
<b>Organizer</b>	Japan Electronics and Information Technology Industries Association (JEITA)
<b>Co-sponsors</b>	Communications and Information Network Association of Japan (CIAJ) Software Association of Japan (SAJ)
<b>Supported by</b>	Ministry of Internal Affairs and Communications (MIC), Ministry of Foreign Affairs of Japan (MOFA), Ministry of Economy, Trade and Industry (METI), Ministry of Health, Labour and Welfare (MHLW), Ministry of Land, Infrastructure, Transport and Tourism (MLIT), Digital Agency (the order of establishment)  Japan External Trade Organization (JETRO), New Energy and Industrial Technology Development Organization (NEDO), National Institute of Advanced Industrial Science and Technology (AIST), National Institute of Information and Communications Technology (NICT), Information-technology Promotion Agency (IPA), Organization for Small & Medium Enterprises and Regional Innovation, Japan (SME Support, Japan) Chiba Prefecture, Chiba City Japan Broadcasting Corporation (NHK), Japan Commercial Broadcasters Association (JBA) Japan Business Federation (Keidanren), Japan Automobile Manufacturers Association, Inc., The Japan Chamber of Commerce and Industry, The Tokyo Chamber of Commerce and Industry, The Chiba Chamber of Commerce and Industry U.S. Commercial Service, U.S. Embassy, Japan, Ontario Trade and Investment Office, Embassy of Canada to Japan, EU-Japan Centre for Industrial Cooperation, Embassy of the United Arab Emirates in Japan, Embassy of Latvia in Japan, Embassy of Ukraine in Japan
<b>Management</b>	CEATEC Management Office (Japan Electronics Show Association (JESA))



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# CEATEC<sup>®</sup> AWARD

CEATEC AWARD 2024 encourages the realization of Society 5.0. The purpose of this program is to contribute to the creation and development of new value and markets, and to revitalize related industries. This year again, the CEATEC AWARD 2024 judging committee selected the winners from among the many applications received.

## CEATEC AWARD 2024 Review Panel of Judges

### Academic Societies (in no particular order)

Information Processing Society of Japan / The Institute of Electronics, Information and Communication Engineers  
/ The Institute of Image Information and Television Engineers / The Institute of Electrical Engineers of Japan

### Research Institute and Media Related (in no particular order)

MM Research Institute, Inc. / The Nikkan Kogyo Shimbun, Ltd. / Nikkei Business Publications, Inc. / ITmedia Inc. / Techno-core Corporation



### ViXion01S - Next generation eyewear that replaces and extends the focusing function of the eye

ViXion Corporation

Booth 5H251



Advanced eyewear with automatic focus adjustment tailored to individual vision needs. Using integrated sensors, it measures object distance and instantly adjusts variable-focus lenses through proprietary algorithms, ensuring seamless autofocus functionality. Ideal for individuals with diverse vision conditions such as presbyopia, myopia, or amblyopia. Perfect for precision tasks requiring both hands or activities involving frequent transitions between near and far vision.



### Outdoor-ready A0 size ePoster

Sharp Corporation

Booth 7H502



Sharp has developed a large A0-size electronic paper display, which can maintain a static image with zero power consumption. This ePoster can be installed outdoors and, as it uses reflected ambient light to display images, it is ideal for bright outdoor locations. There is demand for adopting digital technologies to create such large poster-style displays to serve as outdoor signage, at bus stops, etc. Combining a solar power generation system, this smart electronic poster is environmentally friendly, suitable for outdoor installation, and offers large dimensions.



### Digital Twin Software [TRANCITY]

CalTa Corporation

Booth 6H163



By simply uploading video clips to a web browser, anyone can easily generate 3D data with this digital twin software. As well as dimensional information, the resulting 3D data contains positional and chronological information. By overlaying this (at actual size) on various maps, such as Google 3D maps, it is possible to grasp at a glance the "what, when and where" of infrastructure facilities. It is already being used for a wide range of purposes focused on infrastructure maintenance and management as well as construction.



### NEC's Video Recognition x Generation AI for Industrial DX Promotion and Business Efficiency

NEC Corporation

Booth 4H125

#### Generative AI (LLM) × Video Recognition

The world's first technology that extracts relevant video scenes from long video footage and generates descriptive text according to user's requests



This is the world's first technology that recognizes and understands various objects and environments—such as people, cars, buildings, animals, trees, and weather conditions, in long video data and their changes, and extracts relevant video scenes and generates descriptive text, customized to suit user's requests, using a large language model (LLM) developed by NEC. This technology makes it possible to utilize the vast quantities of video data generated in digital cities and will contribute to advancing industrial DX and enhancing operational efficiency.

# CEATEC<sup>®</sup> AWARD Category Award



HMS Corporation

Booth 5H141

## GEMBA 3D - Automated Muscle Distribution Inspection System by Combination of 3D Sensor and 3D Recognition by Proprietary AI (Japanese only)

Rebar inspection, which is essential for concrete structures, is carried out almost entirely by hand within a limited inspection time, and is a task that places a heavy burden on the construction site for which there is a remarkably high expectation of efficiency improvement. By combining an existing rebar inspection reporting system with a system that utilizes 3D sensors, and point cloud processing/edge clouding AI technologies, it is possible to create a 3D model of the rebar in almost real time, enabling automatic design data verification and automated report creation, as well as achieving unprecedented efficiency in the field of construction rebar inspection.

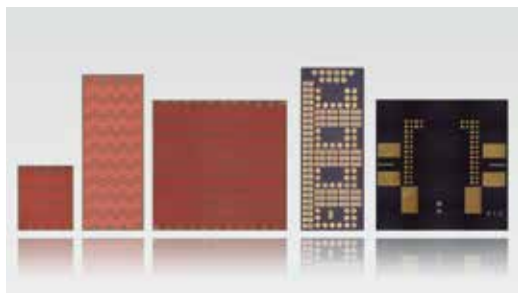


TDK Corporation

Booth 4H100

## Fourth Passive Components Using Spintronics Technology Reduces Power Consumption of AI Devices to 1/100

The rapid spread of AI has led to a sharp increase in power consumption in the ICT field, which has become a social issue. One of the factors contributing to this is the power consumption of semiconductors. Memristors are analog elements that mimic the synapses of the human brain, and are referred to as the fourth passive components following resistors, capacitors and inductors. AI circuits that include spin memristors using spintronics technology no longer have to perform digital logic calculations, and ultra-low power consumption can be expected in AI products from data centers to the edge.



Murata Manufacturing Co., Ltd.

Booth 6H104

## Substrate with built-in capacitor/inductor (iPaS) that contributes to higher performance and power saving of leading-edge semiconductors.

With the steady progress of AI and IoT, the volume of data traffic is growing rapidly. And while there is a strong demand for high-performance semiconductor packages, their increased power consumption poses a problem. The challenge is to achieve both high performance and energy efficiency. Developed exclusively by Murata Manufacturing, iPaS is a substrate product that integrates components such as capacitors and inductors. By embedding into the substrate SMD components that require a large mounting area, iPaS contributes to reducing the space and power requirements of a customer's products while enhancing their functionality.

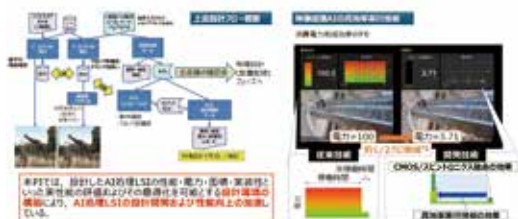


Keio University Consortium for Backscatter Communications Research

Booth 5H221

## Synchronous, Multi-channel, Battery-free Wireless Sensing System

By combining wireless power transmission with backscatter communications—using reflected signals to transmit data—this team has devised and developed a wireless chip, a reader, and a wireless communication protocol for enabling wireless communications while wirelessly powering commercially available sensors. It is now possible to create wireless sensors that are battery-free and ultra-lightweight (< 1g), which can be embedded in products to enable 24/7 sensing, even when the object is in use. The team is conducting a battery of verification tests at the same time as promoting the adoption of this made-in-Japan wireless communication protocol as a new ISO standard.



National University Corporation Tohoku University

Booth 5H102

## CMOS/Spintronics Fusion AI Semiconductor

The increasing volume of data that is being processed today poses a problem. As a possible solution, the team has developed an edge AI computing technology based on CMOS/spintronics fusion (high-level fusion of CMOS and spintronics technologies). This R&D project encompasses the development of technology for the efficient design of a CMOS/spintronics fusion semiconductor, as well as applied research aimed at using it in edge-based surveillance systems and in-vehicle systems.



# CEATEC<sup>®</sup> AWARD Category Award



Ezowin Corporation

Booth 3H091

## Reposaku - Ultra-high precision GPS logger for "just plug it in, easy, agricultural DX".

This product, developed by Ezowin, a startup company based in Shibetsu, Hokkaido, created the "Just plug it in, an Easy DX" system. Simply plug the GPS logger into the vehicle's power supply (USB) to draw an accurate real-time map of the vehicle position of all workers on the field. It has been proven to improve work efficiency by 18% by making it easier to check progress and reducing unnecessary movement. In addition, it has also been proven to have a stress-reducing effect including reduction of the administrative task burden by 58%. It is also possible to output daily reports and perform analysis using high-precision data.



Trimatis Corporation

Booth 2H098

## Underwater Fusion Sensor

This is a sensor that acquires 3D data in real time underwater. Equipped with three colors of visible light lasers (red, green, blue) that have low propagation loss underwater, it is possible to switch the light source used for each season and/or sea area, and to measure detailed 3D data underwater at high speed, which has previously been impossible. It is also equipped with an RGB camera, and it is possible to acquire 3D point cloud information underwater, in color. It will assist in the acquisition of learning data to promote AI in the future underwater and undersea.



Gaia-X European Association for Data and Cloud AISBL

Booth 5H234

## Data doesn't flow on rainbows

Software and specifications that allow corporations and individuals to exchange and share data. Compliance engine, registry and notary are included in the software component, which are deployed by the Gaia-X Digital Clearing House (GXDCH). These tools work together, and data is distributed in a way that conforms to the standards set by Gaia-X. This allows participants to share data while maintaining control over its distribution. In addition to the software, Gaia-X provides specifications such as compliance documents, ICAM, and architecture documents. This documentation outlines the rules, technical standards, and best practices that participants must comply with in order to ensure the integrity, security, and privacy of exchanged data. By ensuring that all participants in the ecosystem adhere to the same standards, Gaia-X will achieve a highly reliable data distribution environment without compromising the rights and control of data owners.



YNEURO

Booth 5H234

## Neuro ID<sup>®</sup> : The Ultimate Secure Biometric Solution

A pioneering biometric authentication system that uses each individual's unique neural signature to revolutionize personal identification. Unlike traditional methods, Neuro ID utilizes a non-replicable neural pattern to provide a secure, private and seamless alternative. This technology eliminates the need for passwords and physical biometrics, greatly reducing the risk of security breaches. The system's adaptive learning capabilities allow for continuous improvement in recognition accuracy, providing a highly personalized user experience. The versatility of this system has the potential to revolutionize digital security in fields such as finance, government, defense, and consumer electronics.

CEATEC  
AWARD

2021

総務大臣賞

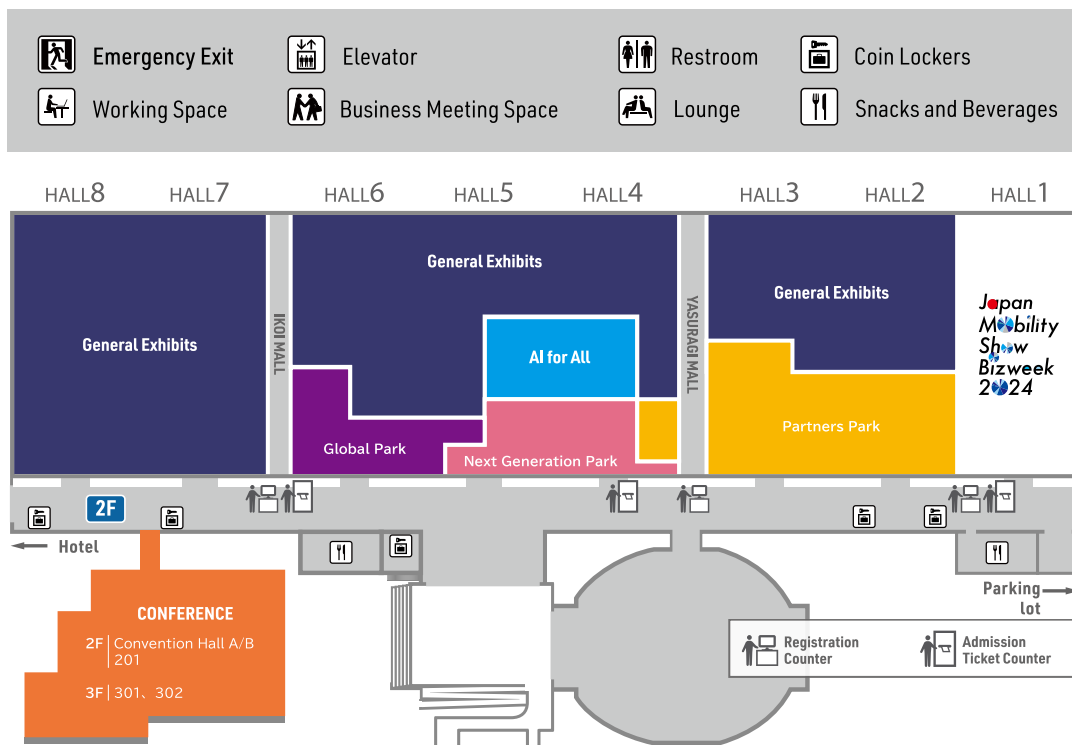
CEATEC  
AWARD

2021

CEATEC 25周年特別賞



## Venue MAP



### General Exhibits

An area for technologies, electronic components/devices, solutions and services in general, looking toward the future with the introduction of AI for the realization of Society 5.0.

### AI for All

The "AI for All" special program for CEATEC's 25th anniversary will showcase the future society that will undergo major changes and the latest technologies and solutions, together with companies and organizations that are at the forefront of changing the world with AI.

### Next Generation Park

An area where startups and educational institutions that will lead the next generation will showcase their technologies and research results.

### Partners Park

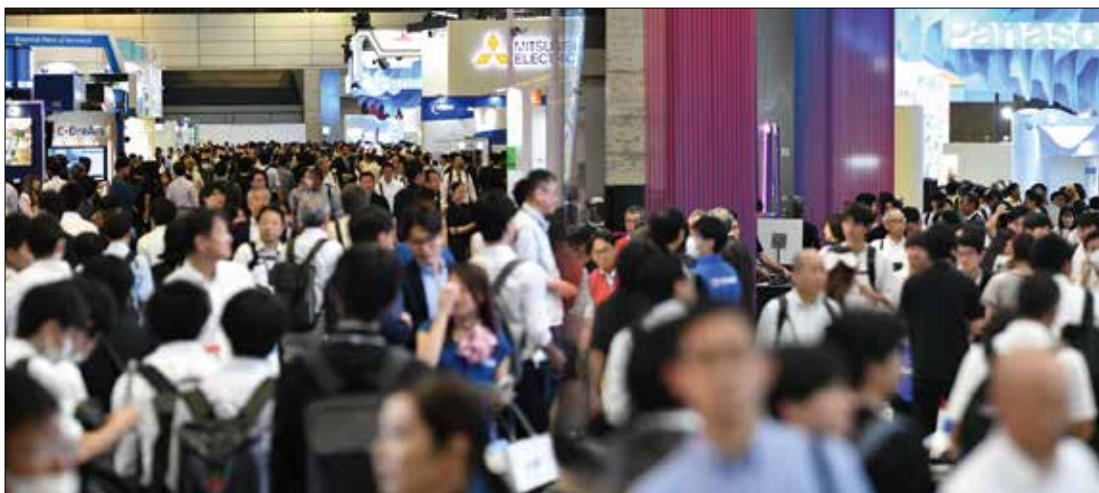
This is a "co-creation" area that embodies the future society of Society 5.0 with partners from all industries and business sectors under a unique theme.

### Global Park

An area where pavilions and other complexes will be set up to showcase cutting-edge technologies and innovative solutions from countries and regions around the world.

### Conference

227 sessions will be held at Makuhari Messe and online. In addition to sessions at the International Conference Hall, an open stage will be held in the exhibition hall.



8H405

**SONY**

Sony Group

Linde AMT Japan  
FUKUDENSHIZAI  
SANYO  
PMT  
Inabata  
DISCO  
Seinan Industries  
DESIGN NETWORK  
Litho Tech Japan  
TATEYAMA MACHINE  
Sanyu  
Nakamura-Tome Precision  
Industry  
National Institute of Advanced  
Industrial Science and  
Technology AIST  
SPP Technologies  
Yokogawa Solution Services  
HORIBA STEC  
SAKAGUCHI ELECTRIC HEATERS  
Logic Research  
YONEKURA MFG  
Hundred Semiconductors  
Denka  
MITANI SANGYO  
TOKAI RIKAI  
JAPAN BLUE  
Kumamoto Bosei Kogyo  
NIPPON SHOKUBAI  
Materialgate

8H461



Minimal Fab  
Promoting Organization

8H541



Delta Electronics Japan







# HALL 6



# HALL

IKOJI MALL

6H105

Panasonic Group

6H104

Murata Manufacturing

5H103

Mitsubishi Electric

AITOZ MACHINERY  
iPresence  
Adacotech  
AltoAir  
Aecom  
CHALCOGENIC  
COSMOS WEB  
SHISEI DATUM  
Sinfonia  
T2 Laboratory  
TRIALPARK  
Nishikawa Seiki Seisakusho  
KNIT  
Japan System Development  
FORESIGHT  
PROSPINE  
Protect  
HoLo360  
Mabuchi Engineering  
Le Grand

6H106

Tokyo Metropolitan Small and Medium Enterprise Support Center (Tokyo Business Frontier)

6H107 Taiwan Electrical and Electronic Manufacturers' Association (TEEMA)

INSTITUTE FOR INFORMATION INDUSTRY  
Taiwan Electrical and Electronic Manufacturers' Association  
LENDI ELECTRONICS  
SFELECTRONICS TECHNOLOGY  
HIGSTEC  
SUNLIKE DISPLAY TECHNOLOGY  
EXPLUS  
SIN YU TECHNOLOGY  
WISITIP DISPLAY  
ASUKA AUTOTRONICS  
KINGSTATE ELECTRONICS  
FIVETECH TECHNOLOGY  
EXCEL CELL ELECTRONIC  
LINSHIUNG ENTERPRISE  
HTP ASIA TECHNOLOGY  
NAVISYS TECHNOLOGY

6H108

KOA

5H109

Keysight Technologies

5H111

HOKURIKU ELECTRIC INDUSTRY

5H112

VisasQ

5H113

Yokowo

6H151

Sumitomo Mitsui Auto Service

6H150

ANRITSU

6H149 Riken  
6H147 brlab  
6H148 OSTIARIES

5H146 CMF Design Lab  
5H145 Dracula Technologies  
5H144 artience  
5H142 JOIE  
5H143 Aryballe / SUN-WA Technos

5H140 Topre  
5H139 JHOSON DOCUMENTS  
5H138 GT CONTACT  
5H137 SUMITOMO BAKELITE

5H135 WIZAPPLY  
5H134 FORUM8

DARWIN PRECISIONS

MIA Technologies

6H152

Embassy of the United Arab Emirates in Japan  
syd.life  
Bitgrit  
Momint  
Liquidity Group  
Aquaai  
Lemonade Fashion  
IT Flakes  
TAMM  
AR Engineering  
Farmin  
Nutralis  
Sulmi  
Falcon Robotics  
Hyvegeo

UAE Pavilion

6H231

6H156

Frore Systems

Kawamura International

6H160 HAGIWARA TECHNO SOLUTIONS  
6H168  
6H161 Gijutsu-Hyoron  
6H162 FLH  
6H163 CalTa

5H169

AlphaDrive

5H171 MAGTAME TECHNOLOGY  
5H178 Lefixea  
5H177 Sanoh Industrial  
5H172 GUGEN  
5H176 LivAI  
5H173 Kisui Tech  
5H175 No.1 Solutions  
5H174

5H179 NIPPON SHOKUBAI  
5H184 STUFF  
5H181 Pocket Queries  
5H183 CORNES Technologies  
5H182

CASIL SEMICONDUCTOR / CHIPPOW MICROELECTRONICS (HUZHOU)

Shenzhen YuansuChuangda Technology

6H232

U.S. Pavilion  
U.S. Commercial Service Japan, U.S. Embassy  
American State Office Association (ASOA)  
Alarm.com  
Qualtrics  
Globalstar Japan  
AR Genie

6H233 Taiwan Innovations & Cybersecurity Pavilion

Taiwan Information Security Association (TWISA)  
ROUTINGTECH  
ChoozMo  
Lydsac Digital Technology Japan  
Infinitix Japan  
CHANGING Information Technology

IsCoolLab  
Yallvend Tech  
SHARETECH INFORMATION  
KeyXentic  
ZUSO Generation  
Authme

5H234

EU Pavilion

5H238

Canada, Ontario Pavilion  
Government of Ontario, Ministry of Economic Development, Job Creation and Trade  
NISO Energy  
INAGO  
Content Interface  
BluWave-ai  
NuraLogix

## Global Park

6H329 Wordly

Global Lounge

6H330

Ukraine Pavilion  
Ukraine, Odesa IT Family

6H331 LATVIA Pavilion

Investment and Development Agency of Latvia (LIAA)  
Vivid Tech  
Linearis  
Handwave  
Aretai

Pitch Stage B

5H239-5H242

Japan External Trade Organization  
Criteo Optics  
Amaru Technologies  
Streptogramin  
CyberLife  
Calculus  
SUNSHINE TECHNOLOGY  
Shanghai VISION 2020  
Shanghai Future Pavilion

5H243

Tokyo Women's Medical University  
Faculty of Advanced Techno Surgery  
5H244 WhiteLab  
5H245 Block

EU-Japan Centre for Industrial Cooperation  
Enterprise Europe Network Japan  
Gala-X  
Alternative Energy Innovations SL  
AVISense.AI  
Cequense s. r. o.  
Geomatics Research & Development srl (GRoD)  
Scriptide  
Secure-IC  
Yneuro  
TenderHut  
Zentrix

Press center







5



HALL 4

YASURAGI MALL

5H102

New Energy and Industrial Technology Development Organization (NEDO)

4H101

NEXTY Electronics

4H100

TDK

## Exhibits

5H114

Panasonic Industry

5H115

CDR Eco-Movement

5H116

CRI Middleware

4H118

EHOMWEI

4H121

Advanet

4H124

Central Nippon Expressway

4H125

NEC Group

5H133

RIKEN

5H132

Yokogawa Digital ALGO ARTIS GHILIA

4H131

CyberAgent

4H130

TOPPAN Digital

4H128

JEITA Display Devices Board / Electronic Components Board

4H127

JEITA Electronic Components Board / Display Devices Board

4H126

Speeda

## AI for All

5H185

Information-technology Promotion Agency, Japan (IPA)

AI for All Stage

4H187

Alsmiley

4H188

Nippon Television Network

4H189

Advanced Media

4H190

Fujikura

4H195

Preferred Networks

4H194

sakurainternet Prunus-Solutions

4H193

maris creative design

4H191

Japan C&T Display

Backscatter Communication Research Consortium, Keio University

New Innovations (IoD)

OceanEyes

Kanban Innovation Initiative (KSI) / Urban Innovation Institute

SH229 Helifuel

SH244 CREATION DRIVE

Sanyo Chemical Industries

Needs Explorer

SH231

SH241 MP-6

SH245

SH246

SH248

SH250

SH251

SH253

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## Next Generation Park

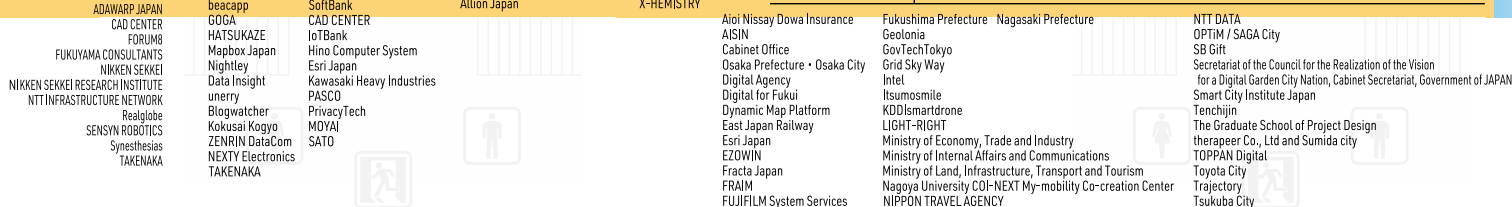
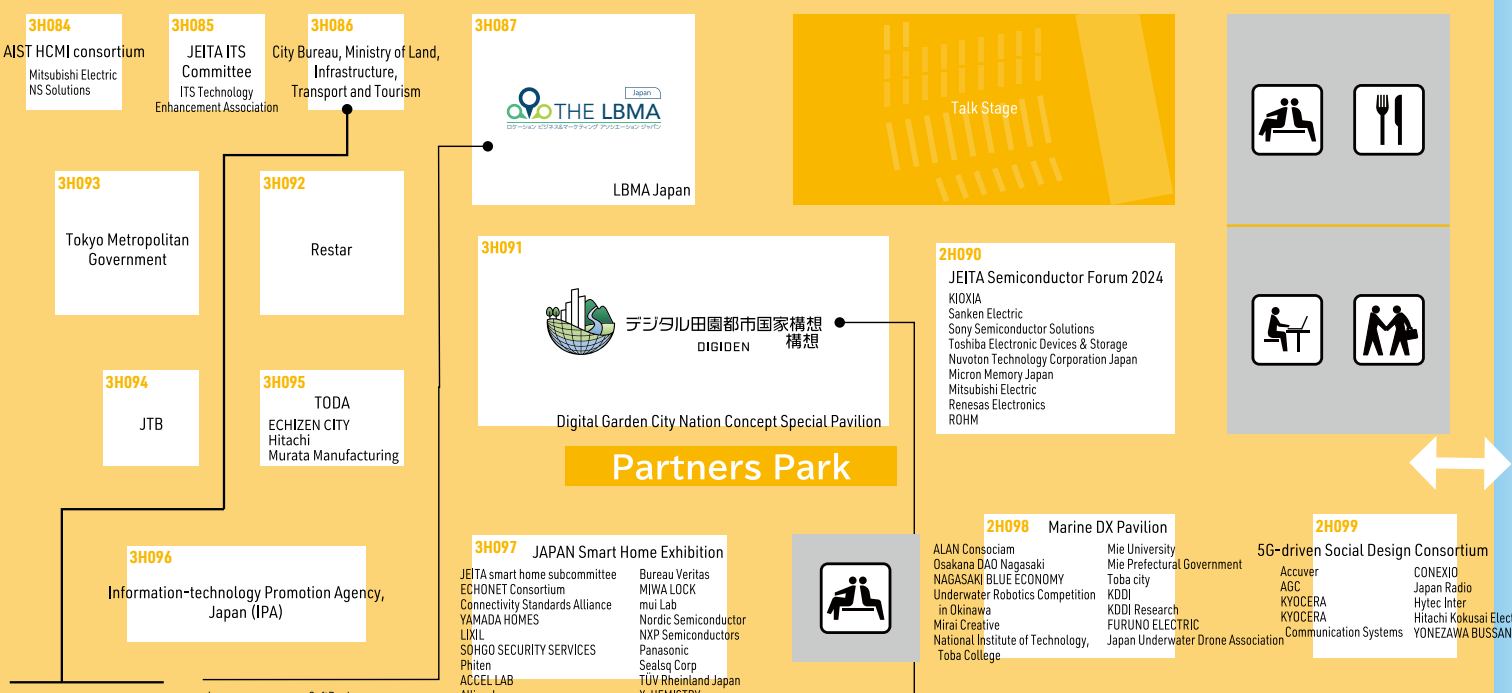
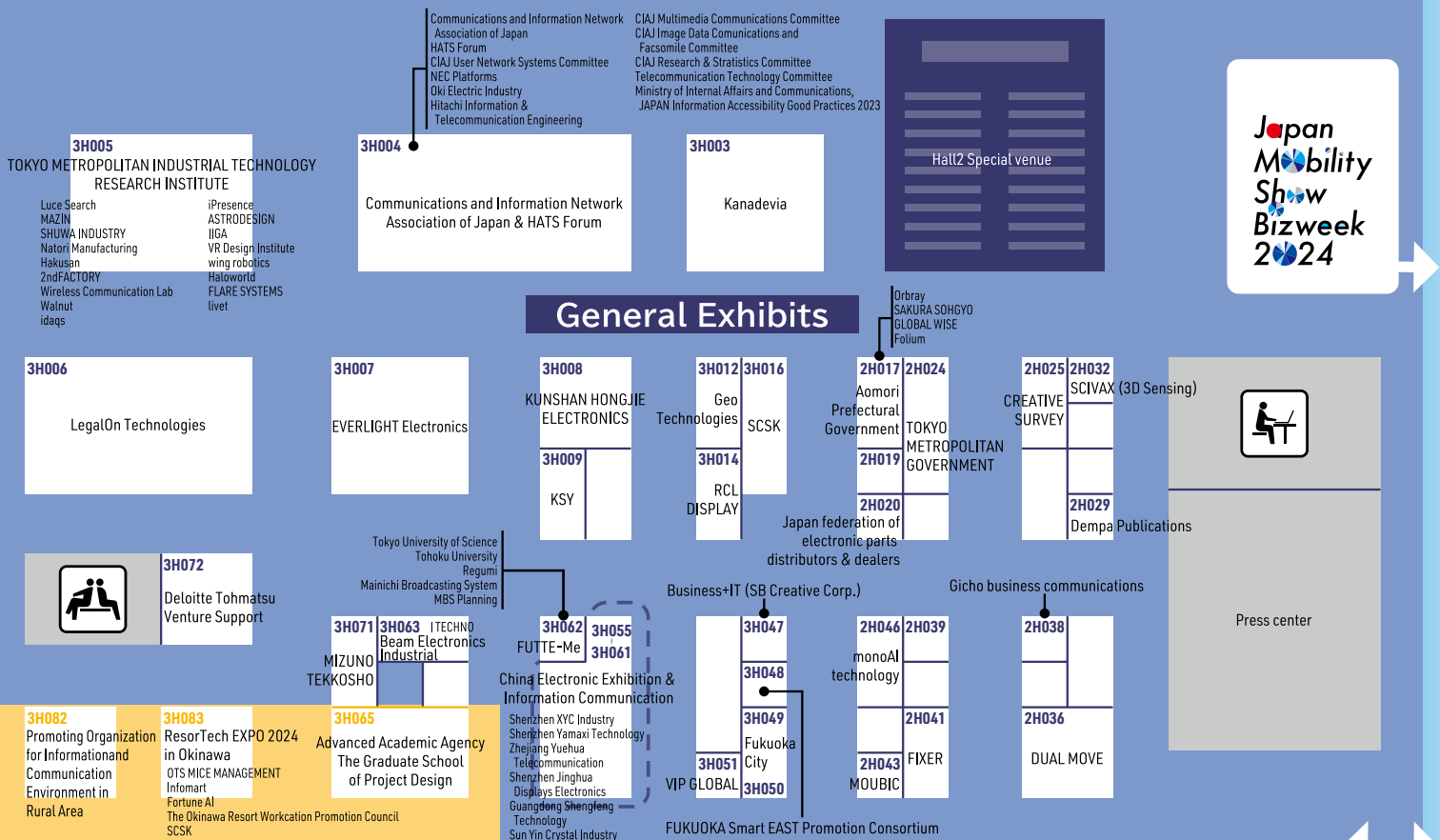




## HALL 3



## HALL 2



# Exhibitor List (Alphabetical Order / As of October 2)

Area Composition ■ General Exhibits ■ AI for All ■ Partners Park ■ Next Generation Park ■ Global Park

## A

■ 8H471 ABA Co., Ltd.  
■ 4H196 ABeam Consulting Ltd.  
■ 8H526 Acompany Co., Ltd.  
■ 8H524 adlib ltd.  
■ 3H065 Advanced Academic Agency  
The Graduate School of Project Design  
■ 4H189 Advanced Media, Inc  
■ 4H121 Advanet Inc.  
■ 8H540 A, Inc.  
■ 8H523 AISIN  
■ 4H187 Alsmiley.Co. Ltd  
■ 3H084 AIST HCMI consortium  
Mitsubishi Electric Corporation  
NS Solutions Corporation  
■ 5H169 AlphaDrive  
■ 7H422 Amaryllo Inc.  
■ 4H291 Animotech Inc.  
■ 5H355 ANKR DESIGN Inc.  
■ 6H150 ANRITSU CORPORATION  
■ 2H017 Aomori Prefectural Government  
Orbray Co., Ltd.  
SAKURA SOHGYO CO., LTD  
GLOBAL WISE Inc.  
Folium.k.k  
■ 5H253 Aoyama Gakuin University  
Computer Human Interaction Lab (Itoh Lab)  
■ 8H433 Archeress Inc.  
■ 8H481 AREX Inc.  
■ 7H497 Aroma Bit, Inc.  
■ 5H144 artience Co., Ltd.  
■ 8H465 Artience Lab Inc.  
■ 5H143 Aryballe / SUN-WA Technos  
■ 7H514 Association of Radio Industries and Businesses  
■ 7H508 ATOTO Electronics

## B

■ 5H221 Backscatter Communication Research Consortium,  
Keio University  
■ 5H311 Ballista Corp.  
■ 7H411 Battery Association for Supply Chain  
Asahi Kasei Corp.  
BASF TODA Battery Materials LLC  
Central Glass Co., Ltd.  
Fukui Byora Co., Ltd.  
GS Yuasa International Ltd.  
Hagihara Industries Inc.  
iCAD LIMITED  
JX Advanced Metals Corporation  
KANTO DENKA KOGYO CO.,LTD.  
Komatsu NTC LTD.  
Kubota Corp.  
MATSUDA SANGYO Co.,Ltd.  
Mitsubishi Chemical Corporation  
Mitsubishi Corporation  
Mitsubishi Electric Corp.  
Mitsubishi Materials Corporation  
MU Ionic Solutions Corporation  
Nichia Corp.  
NIHON KAGAKU SANGYO CO.,LTD.  
Nippon Recycle Center Corporation  
NSK Ltd.  
OONO DEVELOPMENT CO.,LTD.  
Panasonic Energy Co., Ltd.  
Powrex Corporation  
Prime Planet Energy & Solutions, Inc.  
Ricoh Co., Ltd.  
Seibu Giken Co., Ltd.  
SEKISUI CHEMICAL CO., LTD.  
SHIBAURA MACHINE CO., LTD.  
SMC Corporation  
SOMPO Light Vortex Co., Ltd.  
Sumitomo Metal Mining Co., Ltd.  
Taikisha Ltd.  
TANABE Corporation  
Toshin Co., Ltd.  
TOYOTA BATTERY Co., Ltd.  
Toyota Tsusho Corporation  
TOYOTA TSUSHO MATERIAL INCORPORATED  
Yamaha Motor Co., Ltd.  
YASKAWA Electric Corporation  
Yodogawa Hu-Tech Co., Ltd.  
■ 3H063 Beam Electronics Industrial Co., Ltd  
I TECHNO Co.,Ltd.  
■ 8H446 BeMap, Inc.  
Edgecore Networks Corporation.  
Good Way Technology Co., Ltd  
■ 5H349 BiPSEE Inc.  
■ 8H438 BizTech, Inc.  
■ 8H434 Blueish Co., Ltd.  
■ 5H402 Bocek, inc.  
■ 6H147 brlab  
■ 4H364 Bunkashihon-soken Co., Ltd.  
■ 3H047 Business+IT (SB Creative Corp.)

## C

■ 4H191 C&T Co., Ltd.  
■ 7H505 CADDi INC.  
■ 6H163 CalTa Inc.  
■ 5H238 Canada, Ontario Pavilion  
Government of Ontario,  
Ministry of Economic Development,  
Job Creation and Trade  
NISO Energy Corporation  
iNAGO Corporation  
Content Interface Corporation  
BluWave-ai  
NuraLogix Corporation  
■ 5H175 CASIL SEMICONDUCTOR CO., LTD /  
CHIPHOW MICROELECTRONICS(HUIZHOU) CO., LTD  
■ 8H527 CC Architect. Inc  
■ 5H115 CDR Eco-Movement Inc.  
■ 4H124 Central Nippon Expressway Company Limited  
■ 8H443 CG Communications Co., Ltd.  
■ 4H275 Chiba Institute of Technology  
■ 8H543 Chiba Prefecture  
Audio Heart Co., Ltd.  
Smart sensing Corporation  
pool dit design Inc.  
BorderTech Co.,Ltd.  
LEAG Solutions Corp.  
Liberaware Co.,LTD  
Work Robotics Co., Ltd.  
GRIPS Inc.  
C1 Ltd.  
Yanekara Inc.  
■ 4H202 Chubu University Tsukawa Laboratory  
■ 4H383 CHUKYO UNIVERSITY Hashimoto Laboratory  
■ 5H351 CHUO Institute of Information and Design  
■ 5H222 CINCA, Inc.  
■ 3H086 City Bureau, Ministry of Land,  
Infrastructure, Transport and Tourism  
ADAWARP JAPAN Inc.  
CAD CENTER CORPORATION  
FORUM8 Co., Ltd.  
FUKUYAMA CONSULTANTS CO., LTD.  
NIKKEN SEKKEI LTD  
NIKKEN SEKKEI RESEARCH INSTITUTE  
NTT INFRASTRUCTURE NETWORK CORPORATION  
Realglobe Inc.  
SENSYN ROBOTICS, Inc.  
Synesthesias Inc.  
TAKENAKA CORPORATION  
■ 8H457 City of Ishikari,Hokkaido  
■ 5H146 CMF Design Lab Co., Ltd.  
■ 5H305 CNA.,Co.Ltd  
■ 5H358 Co-creation Digital Twin Project  
■ 4H361 COLLEGE OF COMPUTER AND MULTIMEDIA  
■ 3H004 Communications and Information Network  
Association of Japan & HATS Forum  
Communications and Information Network  
Association of Japan  
HATS Forum  
CIAJ User Network Systems Committee  
NEC Platforms, Ltd.  
Oki Electric Industry Co., Ltd.  
Hitachi Information & Telecommunication Engineering,Ltd.  
CIAJ Multimedia Communications Committee  
CIAJ Image Data Communications and Facsimile Committee  
CIAJ Research & Statistics Committee  
Telecommunication Technology Committee  
Ministry of Internal Affairs and Communications,  
JAPAN Information Accessibility Good Practices 2023  
■ 5H357 Cooperative Robotics Laboratory, Department of  
Electronic Engineering, Tokyo Denki University  
■ 5H183 CORNES Technologies Ltd.  
■ 8H530 COSMO SOUND Co., Ltd.  
■ 5H244 CREATION DRIVE  
■ 2H025 CREATIVE SURVEY INC.  
■ 5H116 CRI Middleware Co., Ltd.  
■ 8H521 CURIO SCHOOL  
■ 4H131 CyberAgent, Inc.  
■ 8H533 CYBERNET SYSTEM CO., LTD.  
■ 5H255 CybernEX Co., Ltd.

## D

■ 8H436 DAIKO DENSHI TSUSHIN, LTD.  
CAMI&Co  
■ 5H138 DARWIN PRECISIONS CORPORATION  
■ 3H072 Deloitte Tohmatsu Venture Support Co., Ltd  
■ 8H541 Delta Electronics Japan  
■ 7H426 DELTATooling.CO., LTD.  
■ 2H029 Dempa Publications, Inc.  
■ 7H512 DigiOn, Inc.  
■ 3H091 Digital Garden City Nation Concept Special Pavilion  
Aioli Nissay Dowa Insurance Co.,Ltd.  
AISIN CORPORATION  
Cabinet Office  
Osaka Prefecture • Osaka City  
Digital Agency  
Digital for Fukui Co.,Ltd  
Dynamic Map Platform  
East Japan Railway Company  
Esri Japan Corporation

EZOWIN Inc.  
Fracta Japan  
FRAM Inc.  
FUJIFILM System Services Corp.  
Fukushima Prefecture • Nagasaki Prefecture  
Geolonia Inc.  
GovTechTokyo  
Grid Sky Way  
Intel K.K.  
Itsumosmile, Inc.  
KDDISmartdrone  
LIGHT-RIGHT Inc.  
Ministry of Economy, Trade and Industry  
Ministry of Internal Affairs and Communications  
Ministry of Land, Infrastructure, Transport and Tourism  
Nagoya University COI-NEXT My-mobility Co-creation Center  
NIPPON TRAVEL AGENCY CO.,LTD.  
NTT DATA  
OPTiM / SAGA City  
SB Gift Corp.  
Secretariat of the Council for the Realization of the  
Vision for a Digital Garden City Nation, Cabinet  
Secretariat, Government of JAPAN  
Smart City Institute Japan  
Tenchijin Inc.  
The Graduate School of Project Design  
therapeer Co., Ltd and Sumida city  
TOPPAN Digital Inc  
Toyota City  
Trajectory Ltd.,  
Tsukuba City  
■ 8H449 Diver-X, Inc.  
■ 7H487 DKE Holding Company Limited  
■ 7H510 DONGGUAN DONGSONG ELECTRONIC CO., LTD.  
■ 7H492 DONGGUAN XINDIAN POWER SOURCE CO.,LTD  
■ 5H145 Dracula Technologies  
■ 2H036 DUAL MOVE Co., Ltd.  
■ 5H110 DYNACAST

## E

■ 8H474 East Japan Institute of Technology Co., Ltd.  
■ 8H470 EAST JAPAN RAILWAY COMPANY  
■ 7H412 East Nippon Expressway Company Limited  
■ 4H120 EHOMEWEI  
■ 4H390 Eitoss Inc.  
■ 8H486 ELEKS Japan  
■ 8H517 Elephantech Inc.  
■ 4H389 EnergyColoring  
■ 5H234 EU Pavilion  
EU-Japan Centre for Industrial Cooperation  
Enterprise Europe Network Japan  
Gaia-X  
Alternative Energy Innovations SL  
AVISense.AI  
Sequence s. r. o.  
Geomatics Research & Development srl (GReD)  
Scriptide Ltd.  
Secure-IC SAS  
Yneuro  
TenderHut SA  
Zentrix  
■ 3H007 EVERLIGHT Electronics Co., Ltd.

## F

■ 4H283 Final Aim, Inc.  
■ 4H273 Findy Inc.  
■ 2H099 5G-driven Social Design Consortium  
Accuver Co.,Ltd  
AGC Inc.  
KYOCERA Corporation  
KYOCERA Communication Systems Co., Ltd.  
CONEXIO Corporation  
Japan Radio Co., Ltd.  
Hytec Inter Co., Ltd.  
Hitachi Kokusai Electric Inc.  
YONEZAWA BUSSAN Co., Ltd.  
■ 2H041 FIXER  
■ 6H162 FLH Co., Ltd.  
■ 8H479 flourish  
TOKYO.lab  
■ 8H516 FORCIA, Inc.  
■ 5H134 FORUM8 Co., Ltd.  
■ 6H156 Frere Systems  
■ 4H190 Fujikura Ltd.  
■ 7H400 Fujitsu Limited  
■ 3H050 Fukuoka City  
■ 3H048 FUKUOKA Smart EAST Promotion Consortium  
■ 4H208 Fukurovision Co., Ltd.  
■ 8H432 FURUNO ELECTRIC CO., LTD.  
■ 3H062 FUTTE-Me  
Tokyo University of Science  
Tohoku University  
Regumi, Inc.  
Mainichi Broadcasting System  
MBS Planning Corporation

## G



## Exhibitor List

(Alphabetical Order / As of October 2)

Area Composition ■ General Exhibits ■ AI for All ■ Partners Park ■ Next Generation Park ■ Global Park

■ 4H290 Gaianixx  
■ 3H012 GeoTechnologies, Inc.  
■ 2H038 Gicho business communications Co., Ltd.  
■ 6H161 Gijutsu-Hyoron Co., Ltd.  
■ 5H139 GT CONTACT CO., LTD.  
■ 3H060 Guangdong Shengfeng Technology Co., LTD  
■ 5H172 GUGEN, Inc.

## H

■ 6H160 HAGIWARA TECHNO SOLUTIONS CO., LTD.  
■ 8H536 HAMA ELECTRIC LAMP CO., LTD.  
■ 5H239 Helpfeel Inc.  
■ 8H403 Hitachi, Ltd.  
■ 5H141 HMS Co., Ltd.  
■ 5H111 HOKURIKU ELECTRIC INDUSTRY CO., LTD  
■ 8H485 Hong Kong Trade Development Council  
■ 8H456 Huaxin Display Technology (Shenzhen) Co., Ltd  
■ 5H348 Human Academy ITcollege  
■ 8H483 Hutzper Inc.

## I

■ 4H384 ikeriri network service Co., Ltd.  
■ 8H529 Impress Corporation  
■ 5H219 Indian Institute of Technology Hyderabad  
■ 8H538 Industrial Property Cooperation Center  
■ 7H428 Information Processing Society of Japan  
■ 3H096 Information-technology Promotion Agency, Japan (IPA)  
■ 5H185 Information-technology Promotion Agency, Japan (IPA)  
■ 4H206 Institute of Science Tokyo, B5G Team  
■ 7H546 I-PEX Inc.  
■ 7H416 iret  
■ 8H445 ISHIIHYOKI  
■ 8H462 ITALL INC. ( naisen cloud )  
■ 4H371 IWASAKI GAKUEN Information Science College  
■ 4H387 Iwate Prefectural University  
■ 5H245 Iwate Prefectural University Usami Laboratory  
Ihatov Area Information Management  
People Corporation  
Fukken Gijyutsu Consultants Co

## J

■ 4H192 Japan Display Inc.  
■ 5H333 Japan External Trade Organization  
Circle Optics  
Atmosic Technologies, Inc.  
Strangeworks  
cogniBIT GmbH  
Customize PTE. LTD.  
SPINGENCE TECHNOLOGY CO., LTD  
Shanghai YOGO ROBOT Co., Ltd  
Shenyang Vycon Flywheel Co., Ltd  
■ 2H020 Japan federation of electronic parts distributors & dealers  
■ 8H459 Japan OTIC  
■ 3H097 JAPAN Smart Home Exhibition  
JEITA smart home subcommittee  
ECHONET Consortium  
Connectivity Standards Alliance  
YAMADA HOMES Co., LTD.  
LIXIL Corporation  
SOHGO SECURITY SERVICES CO., LTD.  
Phiten  
ACCEL LAB Ltd.  
Allion Japan Inc.  
Bureau Veritas S.A.  
MIWA LOCK Co., LTD.  
mui Lab, Inc.  
Nordic Semiconductor ASA  
NXP Semiconductors N.V.  
Panasonic  
Sealsq Corp  
TÜV Rheinland Japan Ltd.  
X-HEMISTRY  
■ 8H531 Japan Space Systems  
■ 4H128 JEITA Display Devices Board /  
Electronic Components Board  
NEXTY Electronics Corporation  
Sharp Corporation  
Utsunomiya University Yamamoto Laboratory  
Computational Reality Lab., Hosei University  
■ 4H127 JEITA Electronic Components Board /  
Display Devices Board  
ALPS ALPINE CO., LTD.  
■ 3H085 JEITA ITS Committee  
ITS Technology Enhancement Association  
■ 2H090 JEITA Semiconductor Forum 2024  
KIOXIA corporation  
Sanken Electric Co., Ltd.  
Sony Semiconductor Solutions Corporation  
Toshiba Electronic Devices & Storage Corporation  
Nuvoton Technology Corporation Japan  
Micron Memory Japan, K.K.  
Mitsubishi Electric Corporation  
Renesas Electronics Corporation  
ROHM Co., Ltd.  
■ 5H142 JOIE CO., LTD.  
■ 8H454 JR East Consultants Company

■ 3H094 JTB Corp.  
■ 8H458 JVCKENWOOD Corporation

## K

■ 4H302 Kagawa University JST-CREST  
■ 3H003 Kanadevia Corporation  
■ 5H343 KANAZAWA University  
■ 5H229 Kansai Innovation Initiative (KSII) /  
Urban Innovation Institute  
OceanEyes Co., Ltd.  
New Innovations Inc.  
Dsd LLC  
■ 8H435 Kaopiz Inc.  
■ 6H168 Kawamura International Co., Ltd.  
■ 4H396 Keio University Haptics Research Center  
■ 5H109 Keysight Technologies  
■ 5H173 Kisui Tech  
■ 6H108 KOA CORPORATION  
■ 8H407 KODENSHI CORP.  
■ 4H388 Kogakuin University  
■ 3H009 KSY Co., Ltd.  
■ 3H008 KUNSHAN HONGJIE ELECTRONICS CO., LTD  
■ 8H453 Kurimoto, Ltd.  
■ 8H520 KYOWA Engineering Laboratory, Inc.

## L

■ 4H260 Laboratory of Detection of Three-Dimensional  
Center of Gravity  
■ 6H331 LATVIA Pavilion  
Investment and Development Agency of Latvia(LIAA)  
Vivid Tech  
Linearis  
Handwave  
Aretai  
■ 3H087 LBMA Japan  
beacapp Inc.  
GOGA, Inc.  
HATSUKAZE Co., Ltd.  
Mapbox Japan G.K.  
Nightley Inc.  
Data Insight Inc.  
unerry, Inc.  
Blogwatcher Inc.  
Kokusai Kogyo Co., Ltd.  
ZENRIN DataCom CO., LTD.  
NEXTY Electronics Corporation  
TAKENAKA CORPORATION  
SoftBank Corp.  
CAD CENTER CORPORATION  
IoTBank Co., Ltd.  
Hino Computer System Co., Ltd.  
Esri Japan Corporation  
Kawasaki Heavy Industries, Ltd.  
PASCO CORPORATION  
PrivacyTech Inc.  
MOYAI Corporation  
SATO Corporation  
■ 5H178 Lefixea Inc.  
■ 3H006 LegalOn Technologies, Inc.  
■ 4H280 Liberal Logic Inc.  
■ 7H507 Lightning Silicon Technology Inc  
Lakeside Optoelectronic Technology Co., Ltd  
Solos Technology Ltd  
■ 5H176 LivAI, Inc

## M

■ 5H171 MAGTAME TECHNOLOGY CO., LTD  
■ 2H098 Marine DX Pavilion  
ALAN Consociam  
Osakana DAO Nagasaki  
NAGASAKI BLUE ECONOMY  
Underwater Robotics Competition in Okinawa  
Mirai Creative Corporation  
National Institute of Technology, Toba College  
Mie University  
Mie Prefectural Government  
Toba city  
KDDI CORPORATION  
KDDI Research, Inc.  
FURUNO ELECTRIC CO., LTD.  
Japan Underwater Drone Association  
■ 4H193 maris creative design Inc.  
NTT Communications Corporation  
NTT Social Informatics Laboratories  
■ 8H439 Mas Electronics Tech  
■ 7H504 Merci Co., Ltd.  
■ 5H241 MI-6 Ltd.  
■ 5H136 MIA Technologies Limited  
■ 7H413 MIE ELECTRONICS CO., LTD.  
■ 8H431 MI Inc.  
■ 8H461 Minimal Fab Promitiuig Organization  
Linde AMT Japan K.K.  
FUKUDENSHIZAI  
SANYO co., Ltd.  
PMT CORPORATION  
Inabata & Co., Ltd.  
DISCO Corporation

Seinan Industries Co., Ltd  
DESIGN NETWORK CORPORATION  
Litho Tech Japan Corporation  
TATEYAMA MACHINE Co., Ltd.  
Sanyu Co., Ltd.  
Nakamura-Tome Precision Industry Co., Ltd.  
National Institute of Advanced Industrial Science  
and Technology (AIST)  
SPP Technologies Co., Ltd.  
Yokogawa Solution Services Corp.  
HORIBA STEC, Co., Ltd.  
SAKAGUCHI ELECTRIC HEATERS CO., LTD.  
Logic Research Co., Ltd.  
YONEKURA MFG.Co., LTD.  
Hundred Semiconductors inc.  
Denka Co., Ltd.  
MITANI SANGYO CO., LTD.  
TOKAI RIKI CO., LTD.  
JAPAN BLUE Corp.  
Kumamoto Bosei Kogyo, Co., Ltd  
NIPPON SHOKUBAI CO., LTD.  
Materialgate Inc.

■ 8H406 MIRAIT ONE Corporation  
■ 5H103 Mitsubishi Electric Corporation  
■ 8H535 MIXI, Inc.  
■ 7H419 Miyakonojo City  
■ 3H071 MIZUNO TEKOKOSHO CO., LTD.  
■ 2H046 monoAI technology  
■ 4H368 MONOX, Inc.  
■ 2H043 MOUBIC INC.  
■ 5H322 mui Lab, Inc.  
■ 6H104 Murata Manufacturing Co., Ltd.  
■ 4H259 Mysurance

## N

■ 8H477 Nablaworks  
System K Corporation  
■ 7H409 Nagase & Co., Ltd.  
■ 5H250 NAGOYA UNIV. "DII Collaborative Graduate  
Program for Accelerating Innovation in Future Electronics"  
■ 4H301 Nagoya University and Tokyo Metropolitan University,  
CREST CoAugmentation Project  
■ 4H207 Nagoya University, National Institute of Informatics,  
University of Electro-Communications, Osaka University  
Nagoya University  
National Institute of Informatics  
University of Electro-Communications  
Osaka University  
■ 4H210 Nakayama Lab.  
Tokyo University of Agriculture and Technology  
Flyby Co., Ltd.  
■ 7H410 National Institute of Advanced Industrial Science  
and Technology  
■ 7H545 National Institute of Information and  
Communications Technology(NICT)  
■ 4H297 National Institute of Information and  
Communications Technology (NICT)  
AISing Ltd.  
Aromajoin Corporation  
Color SHITSUKAN Laboratory  
Homura Heavy Industries  
LOOVIC Inc.  
National Institute of Technology, Ishikawa College  
New Space Intelligence Inc.  
N-Sports tracking Lab LLC.  
Parity Innovations Co. Ltd.  
Sabotics  
■ 8H544 National Institute of Information and  
Communications Technology (NICT)  
(Innovative ICT Fund Projects for Beyond 5G/6G)  
■ 5H247 National Institute of Technology, Sendai College  
■ 5H353 National Institute of Technology, Tokyo College, Mito .Lab./  
National Institute of Technology ,Sendai College,  
Kobayashi Lab./Tycoh & Co., Ltd.  
■ 7H408 National Space Policy Secretariat, Cabinet Office,  
Government of Japan and Quasi-Zenith Satellite  
System Services Inc.  
■ 4H125 NEC Group  
■ 5H320 Needs Explorer Inc.  
■ 4H289 Network Engineering Laboratory, Faculty of Environmental  
and Urban Engineering, Kansai University  
■ 5H102 New Energy and Industrial Technology  
Development Organization(NEDO)  
■ 4H373 New Energy and Industrial Technology  
Development Organization(NEDO)  
■ 4H101 NEXTY Electronics Corporation  
■ 7H494 NGK INSULATORS, LTD.  
■ 7H493 NHK Foundation  
■ 5H399 Nihon University  
■ 4H122 Nippon Algorithm Co. Ltd  
■ 8H466 Nippon Dempa Co., Ltd  
■ 5H179 NIPPON SHOKUBAI Co., Ltd.  
■ 4H188 Nippon Television Network Corporation  
■ 5H174 No.1 Solutions Inc.

## O

■ 8H480 Oinu Vision. Co., Ltd

# Exhibitor List

(Alphabetical Order / As of October 2)

Area Composition ■ General Exhibits ■ AI for All ■ Partners Park ■ Next Generation Park ■ Global Park

■ 6H148 OSTIARIES Co., Ltd.

## P

- 4H262 PAGODABIZ CO. LTD
- 6H105 Panasonic Group
- 5H114 Panasonic Industry Co., Ltd.
- 4H381 Patentfield Ltd.
- 4H299 Petnow Inc.
- 4H287 Phindex Technologies
- 4H200 Pixie Dust Technologies, Inc.
- 5H181 Pocket Queries, Inc.
- 8H441 Power Management, Ltd.
- NVC Inc.
- 4H195 Preferred Networks, Inc.
- 3H082 Promoting Organization for Information and Communication Environment in Rural Area

## Q

- 8H537 QD Laser, Inc.
- 5H309 QuantumCore, Inc.

## R

- 8H476 rayou Inc,
- 3H014 RCL DISPLAY LIMITED
- 3H083 ResorTech EXPO 2024 in Okinawa
- OTS MICE MANAGEMENT Ltd.
- Infomart Corporation
- Fortune AI
- The Okinawa Resort Workcation Promotion Council
- SCSX Corporation
- 3H092 Restar Corporation
- 5H133 RIKEN
- 6H149 Riken Corporation
- 7H501 Rinnai Corporation
- 4H204 Ritsumeikan University
- Niigata University
- 4H386 Robosensor Lab

## S

- 4H284 Sakaguchi Laboratory, Institute of Science Tokyo
- 4H194 sakurainternet inc.
- Prunus-Solutions Inc.
- 8H444 SANGYO TIMES INC.
- 5H177 Sanoh Industrial Co., Ltd.
- 5H319 Sanyo Chemical Industries, Ltd.
- 2H032 SCIVAX Corporation (3D Sensing)
- 8H484 SCraft Inc.
- 3H016 SCSK Corporation
- 4H277 Secafy Co., Ltd.
- 5H315 SELF Inc.
- 4H201 7Gaa Co., Ltd.
- 7H502 SHARP CORPORATION
- 3H059 Shenzhen Jinghua Displays Electronics Co., Ltd.
- 3H055 Shenzhen XYC Industry Co., Ltd.
- 3H057 Shenzhen Yamaxi Technology Co., Ltd.
- 7H547 SHENZHEN YB TECHNOLOGY CO.,LTD
- 5H182 Shenzhen Yuansu Chuangda Technology Co., Ltd.
- 5H248 Shiryosaku Inc.
- 4H257 Shonan Institute of Technology
- 8H534 Sho-zui Solution Co., Ltd.
- Labpano Technology (Changzhou) Co., Ltd.
- 5H117 SI Synergy Technology Co., Ltd
- 4H392 SK Fine Co.,Ltd.
- 4H271 Smoothie Studio Co., Ltd.
- 4H378 Soft Sensing Devices Division, Yamagata University
- Innovation Center for Organic Electronics
- 5H313 Sonas, Inc.
- 8H405 Sony Group Corporation
- 8H430 SOUYA CO., LTD.
- 8H469 Speech Graphics
- 4H126 Speeda
- 4H282 SPONTO Inc.
- 4H118 Stockmark Inc.
- 4H274 STOVE
- 5H184 STUFF
- 5H137 SUMITOMO BAKELITE CO., LTD.
- 7H414 Sumitomo Metal Mining Co., Ltd.
- Kanazawa University Vibrational Power Generation Laboratory
- 6H151 Sumitomo Mitsui Auto Service Company, Limited
- 8H440 SunLED Life Science
- 5H354 SUNTORY SYSTEM TECHNOLOGY LIMITED
- 3H061 Sun Yin Crystal Industry Co., Ltd.
- 4H391 Sustainable Lab Inc.
- 8H525 SYSTEM RESEARCH CO., LTD.

## T

- 7H418 Taica Corporation
- 6H107 Taiwan Electrical and Electronic Manufacturers' Association (TEEMA)
- 6H107-01 INSTITUTE FOR INFORMATION INDUSTRY
- 6H107-08 Taiwan Electrical and Electronic Manufacturers' Association
- 6H107-23 LENOO ELECTRONICS CO., LTD.

- 6H107-05 SFI ELECTRONICS TECHNOLOGY INC.
- 6H107-03 HIGGSTEC INC.
- 6H107-07 SUNLIKE DISPLAY TECHNOLOGY CORPORATION
- 6H107-19 EXPLUS CO., LTD.
- 6H107-13 SIN YU TECHNOLOGY INC.
- 6H107-18 WISITIP DISPLAY CO., LTD.
- 6H107-15 ASUKA AUTOTRONICS INC.
- 6H107-14 KINGSTATE ELECTRONICS CORPORATION
- 6H107-22 FIVETECH TECHNOLOGY INC.
- 6H107-20 EXCEL CELL ELECTRONIC CO., LTD.
- 6H107-17 LINSHIUNG ENTERPRISE CO., LTD.
- 6H107-21 HTP ASIA TECHNOLOGY CO., LTD.
- 6H107-16 NAVISYS TECHNOLOGY CORP.

- 6H233 Taiwan Innovations & Cybersecurity Pavilion
- Taiwan Information Security Association(TWISA)
- RUITINGTECH CO.,LTD.
- ChoozMo Inc.
- Lydsec Digital Technology Japan
- Infinitix Japan Co., Ltd.
- CHANGING Information Technology Inc.
- IsCoolLab
- Yallvend Tech
- SHARETECH INFORMATION CO., LTD.
- KeyXentic Inc.
- ZUSO Generation Co., Ltd.
- Authme Co., Ltd.

- 7H401 TAIYO YUDEN CO., LTD.
- 4H279 Tamagawa University
- 8H437 TASKAJI Inc.
- 7H489 TATSUTA Electric Wire and Cable Co., Ltd.
- 4H286 TDA Corporation
- 4H100 TDK Corporation
- 7H499 TeamViewer
- 7H513 TechnoBrain Co., Ltd.
- 7H490 TEN FEET WRIGHT INC.
- AirLive Technology Corporation

- 5H256 TGO
- 4H269 The University of Tokyo / Keio University / Shizuoka University (D3-AI Project)

- 4H292 Thinker Inc.
- 5H321 Three Four Six Ink
- 7H415 TOCAD Energy Co., Ltd.
- 3H095 TODA CORPORATION
- ECHIZEN CITY
- Hitachi, Ltd.
- Murata Manufacturing Co., Ltd.
- 8H522 Tohoku-MicroTec Co., Ltd.
- 3H093 Tokyo Metropolitan Government
- 2H024 TOKYO METROPOLITAN GOVERNMENT
- 3H005 TOKYO METROPOLITAN INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
- Luce Search Co.,Ltd.
- MAZIN, Inc.
- SHUWA INDUSTRY COMPANY LIMITED
- Natori Manufacturing Co.,Ltd.
- Hakusan Corporation
- 2ndFACTORY Co., Ltd.
- Wireless Communication Lab, Inc.
- Walnut Ltd.
- idaqs corporation
- iPresence Co., Ltd.
- ASTRODESIGN,Inc
- IIGA Co., Ltd.
- VR Design Institute Inc.
- wing robotics, Inc.
- Haloworld Inc.
- FLARE SYSTEMS Ltd.
- livet Inc.

- 7H498 Tokyo Metropolitan Small and Medium Enterprise Support Center
- Bunkoukeiki Co.,Ltd.
- Filetec Co., Ltd.
- Nippon Dempa Co.,Ltd

- 6H106 Tokyo Metropolitan Small and Medium Enterprise Support Center(Tokyo Business Frontier)
- AITOZ MACHINERY CO.,LTD.
- iPresence Co., Ltd.
- Adacotech Incorporated.
- AltoAir
- Aecom Inc.
- CHALCOGENIC Co., Ltd.
- COSMOS WEB CO.,LTD.
- SHISEI DATUM LTD.
- Sinfonia Inc.
- T2 Laboratory Corporation
- TRIALPARK Co.,Ltd.
- Nishikawa Seiki Seisakusho Co.,Ltd.
- KNiI Inc.
- Japan System Development Co., Ltd.
- FORESIGHT CO.,LTD.
- PROSPINE Co.Ltd
- Profect Inc.
- HoLo360 Inc.
- Mabuchi Engineering Co.,Ltd.
- Le Grand Co., Ltd.

- 4H212 Tokyo University of Technology
- NIHON KOGAKUIN COLLEGE
- 5H403 Tokyo Women's Medical University , Faculty of Advanced Techno Surgery
- 4H123 TOME R&D

- 4H130 TOPPAN Digital Inc.
- 5H140 Topre
- 8H482 toto Co., Ltd
- 4H119 Tourism Forecast Platform Promotion Team
- JTB Corp.
- Opentone Co. ltd.
- PACIFIC CONSULTANTS CO., LTD.
- Azira LLC
- Blogwatcher Inc.
- JORUDAN CO.,LTD.
- JAPAN TRAVEL AND TOURISM ASSOCIATION
- 8H442 Trensor Technology Solutions (P) Ltd.
- 5H314 TriOrb Inc.
- 8H468 TSUBASA CO., LTD.

## U

- 6H152 UAE Pavilion
- Embassy of the United Arab Emirates in Japan
- syd.life
- Bitgrit Ltd
- Momint
- Liquidity Group
- Aquaai
- Lemonade Fashion
- IT Flakes Limited
- TAMM
- AR Engineering
- Farmin Limited
- Nutralis
- Sulmi
- Falcon Robotics
- Hyvegeo
- 6H330 Ukraine Pavilion
- Ukraine, Odesa IT Family
- 8H478 Umee Technologies Inc.
- 5H400 UPBEAT TECHNOLOGY Co., Ltd.
- 6H232 U.S. Pavilion
- U.S. Commercial Service Japan, U.S. Embassy
- American State Office Association (ASOA)
- Alarm.com
- Qualtrics
- Globalstar Japan Inc.
- AR Genie

## V

- 5H360 Valueupdate
- 7H429 VCCI Council
- 3H051 VIP GLOBAL CO.,LTD.
- 5H112 VisasQ Inc.
- 5H251 ViXion Inc.
- 4H366 VMFi Inc.

## W

- 8H539 West Japan Railway Company
- 5H404 WhiteLab Co.,Ltd.
- 5H135 WIZAPPLY Co., Ltd
- JHOSON DOCUMENTS Inc.
- 6H329 Wordly Inc.
- 7H503 Wovn Technologies, Inc.

## X

- 8H463 Xacti Corporation
- 7H423 Xgrids
- Active Retech Inc.
- kudan Inc.

## Y

- 4H376 Yamagata University INOEL Flexible Electronics
- 4H374 Yamagata University INOEL
- High density thin film device
- 4H377 Yamagata University, INOEL,
- Next Generation Solar Cell Division
- 4H375 Yamagata University, Suzuri Lab.
- 7H506 Yeebo Display Ltd.
- 5H132 Yokogawa Digital Corporation
- ALGO ARTIS CORPORATION
- GHELIA INC.
- 4H379 YOKOHAMA National University
- 5H113 Yokowo Co., Ltd.
- 8H460 Yukai Engineering Inc.

## Z

- 5H345 ZENKIGEN
- Aoyama Gakuin University
- 4H197 01Booster Inc.
- 8H518 ZEROUNIT, Inc.
- 4H203 Zeteoh, Inc.
- 3H058 Zhejiang Yuehua Telecommunication Co., Ltd.
- 4H209 ZUVA Inc.

## CONFERENCE & EVENT

Conference

October 15<sup>th</sup> Tue

10:00 - 11:30

### Opening Ceremony & 25th Anniversary Special Session "AI Creating the Future: Innovation and Challenges"

#### Opening Ceremony 10:00~



**Mr. Kazuhiro Tsuga**

Chairperson, Japan Electronics and Information Technology Industries Association  
/ Chairperson of the Board, Panasonic Holdings Corporation



**Mr. Toshihito Kumagai**

Chiba Prefecture Governor



**Mr. Leif Lindner**

CEO, IFA Management GmbH

#### The Future Opened up by OpenAI 10:30~



**Mr. Tadao Nagasaki**

CEO, OpenAI Japan G.K.

#### The potential that AI brings to Japan and its future prospects



**Mr. Kunihiro Tanaka**

Founder & CEO, President, SAKURA internet Inc.



Moderator

**Mr. Kazuyuki Okudaira**

Senior Writer, Nikkei



**Mr. Toshihisa Okada**

VP of Solution Business, Preferred Networks, Inc.



12:00 - 13:00

### Plant Engineering × Digital - The Future Society Realized by Kanadevia -



**Mr. Michi Kuwahara**

PRESIDENT & CHIEF OPERATING OFFICER, Kanadevia Corporation



**Mr. Munenobu Hashizume**

DIRECTOR & MANAGING EXECUTIVE OFFICER GENERAL MANAGER  
INFORMATION AND COMMUNICATION TECHNOLOGY PROMOTION  
HEADQUARTERS, Kanadevia Corporation

13:00 - 14:30

### Towards the realization of a sustainable society ~Diverse frontrunners share their thoughts~



**Mr. Masanori Katayama**

Chairman and Representative Director, Isuzu Motors Limited



**Mr. Keisuke Toji**

CEO, Aeronext Inc.



**Ms. Sachiko Nishioka**

Representative Director, AWESOME Association Inc.



**Mr. Kazuhiro Tsuga**

Chairperson of the Board, Panasonic Holdings Corporation



**Ms. Yuriko Kato**

President, M2 Labo Inc.



Moderator

**Ms. Asuka Sakuma**

Caster, Nikkei CNBC Japan, Inc.

14:40 - 15:40

### It's Smart Glass + AI Era



**Dr. John C.C. Fan**

Chairperson, Lightning Silicon Technology Inc

15:00 - 16:30

### Digital Garden City Nation Concept

#### Opening Remarks



**Mr. Satoshi Ebihara**

CABINET SECRETARIAT

#### Panel Discussions



Moderator

**Mr. Hiroshi Iwama**

COUNCILLOR, CABINET SECRETARIAT



Panelist

**Mr. Akira Miura**

Deputy Manager, Group of Service for Citizens, Digital Agency



Panelist

**Mr. Iwao Miyamoto**

Director-General, Regional Economic and Industrial Policy Bureau



Moderator

**Ms. Risa Tanaka**

President, The Graduate School of Project Design



Panelist

**Mr. Kaoru Onda**

Director-General for Policy Coordination, Ministry of Internal Affairs and Communications



Panelist

**Mr. Masaharu Amano**

Director-General, National Spatial Planning and Regional Policy Bureau



Conference

October 16<sup>th</sup> Wed

10:30 - 12:00

**RIKEN Leading the way: AI for Science - Innovation in Scientific Research -****Dr. Makoto Taiji**

Program Director, Advanced General Intelligence for Science Program, RIKEN

**Dr. Satoshi Matsuoka**

Director, Center of Computational Science, RIKEN

**Mr. Yukio Kobayashi**

Chief Editor, Mynavi News

10:00 - 12:30

**5G/6G Special Day I****Opening Remarks****Mr. Hironobu Yumoto**Director-General, Ministry of Internal Affairs and Communications  
Telecommunications Bureau**Dr. Hiroyuki Morikawa**

Co-Chairperson, XP Mobile Promotion Forum Professor, The University of Tokyo

**Presentaion****Mr. Yo Koide**Manager, Maglev Systems Development Division, Chuo Shinkansen Promotion  
Division, Central Japan Railway Company**Mr. Maxime Flament**

Chief Technology Officer, 5G Automotive Association (5GAA)

**Mr. Ray Tseng**

Head of ECE (Enterprise Campus Edge) Sales, APAC, Nokia

**Mr. Hiroshi Sugita**

CTO, KDDI SmartDrone Inc.

**Mr. Ryuji Wakikawa**Vice President, Head of Research Institute of Advanced Technology,  
SoftBank Corporation

13:30 - 14:30

**State of Smart Hom and Future of Smart Home****Mr. Fumi Shingai**

CEO, X-HEMISTRY Inc.

**Mr. Yoshihiro Tachibana**Senior Manager of Residential Business Plannning Department,  
Mitsubishi Estate Co., Ltd.**Mr. Munehiko Sato**

Chief Experience Officer, mui Lab, Inc.

**Mr. Tugutaka Aoki**

Director/CTO, ACCEL LAB Ltd.

14:00 - 17:00

**5G/6G Special Day I Local 5G International Workshop  
"Factory/Manufacturing Industry + Global Frontline Challenging Business Development"****Opening Remarks****Mr. Hiroyuki Ogawa**

Ministry of Internal Affairs and Communications

**Lectures****Mr. Masakazu Shiota**

Ambassador, 5G-ACIA Japan

**Ms. Satoko Itaya**Research Manager, Wirelesss System Lab, National Institute of Information and  
Communications Technology Network Research Institute**Mr. Gaku Hibi**

KYOCERA Communication Systems Co., Ltd.

**Mr. Koichiro Fujimoto**

NEC Corporation

**Mr. Brian Huang**

REIGN Technology Corporation

**Mr. Thomas Fuerst**

Verizon

**Speech****Dr. Susumu Yoshida**

Professor, Kyoto University

15:30 - 16:30

**The ideal and reality of generative AI -What changes will AI bring to technological innovation,  
semiconductors, electricity, new business models, and society?****Mr. Ichiro Sato**

National Institute of Informatics

Conference

October 17<sup>th</sup> Thu

10:30 - 11:30

## Realization of AI Factory ~ Scale-up, scope expansion, and knowledge accumulation



**Dr. Hiroaki Kanokogi**

Chief Executive Officer, Yokogawa Digital Corporation

10:00 - 17:00

## 5G/6G Special Day I 5G/6G Special Day I 5G/6G International Conference

### Opening Remarks



**Mr. Koichi Takemura**

Ministry of Internal Affairs and Communications



5G and Beyond

**Mr. Hermano Tercius**

Ministry of Communications Secretary of Telecommunications, Brazil



5G and Beyond

**Mr. Masayuki Matsui**

Ministry of Internal Affairs and Communications



5G and Beyond

**Mr. Iwao Hosako**

National Institute of Information and Communications Technology (NICT)



Korea's 6G R&D Promotion Strategy

**Mr. Chung Jaehoon**

Ministry of Science and ICT



Status of 6G R&D and Evolution Path to AI Telco Infrastructure

**Mr. Kim Phirun**

Ministry of Post and Telecommunications

### Panel discussion



**Mr. Akihiro Nakao**

Co-chairman, XG Mobile Promotion Forum



**Mr. Matti Latva-aho**

6G Flagship



**Mr. Abhimanyu Gosain**

Northeastern University



**Mr. Paul Wijngaard**

TNO - National Research institute of applied science Alliance Director 6G FNS Program Board



Status of 6G R&D and Evolution Path to AI Telco Infrastructure

**Mr. Yu Takki**

SK Telecom



Views on 5G and 6G

**Ms. Wang Xiaoyun**

China Mobile



Orange's perspective on 6G

**Mr. Eric Hardouin**

Orange



Technology Innovation on the Path to 6G

**Mr. Lorenzo Casaccia**

Qualcomm Technologies, Inc.



Evolution of Mobile Communication towards 6G

**Mr. Juho Lee**

Samsung Electronics Co., Ltd.



Evolution of Mobile Communication towards 6G

**Mr. Wen Tong**

Huawei Wireless CTO



TSB Director's video Message to 5G-6G INTERNATIONAL CONFERENCE

**Mr. Seizo Onoe**

International Telecommunication Union Director of the Telecommunication Standardization Bureau

### Closing Remarks



**Mr. Seiji Nishioka**

Association of Radio Industries and Businesses

12:00 - 13:00

## Toward the AI Society



**Ms. Akiko Murakami**

AI Safety Institute, IPA

13:30 - 14:30

## Toward the Realization of Society 5.0 in Hot Springs Tourism Areas



**Mr. Hiroki Moriguchi**

JTB Corporation



**Mr. Mitsuhiro Miyazaki**

Takara Sou Hotel



**Mr. Genri Goto**

CEO, Kotozna, Ltd.



**Ms. Kaoru Johou**

CEO, Tablecross

15:00 - 16:30

## EU-Japan Global Dialogue on data space



**Mr. Takeshi Fujii**

SVP, Co-Head of Strategic Planning Unit, Global Solutions Business Group, Fujitsu Limited

### Panel discussion



**Mr. Bjoern Juretzki**

European Commission - DG CONNECT Head of Unit, Data Policy and Innovation



**Mr. Hagen Heubach**

Catena-X Member of the Executive Board Catena-X e.V.



**Mr. Gaku Moriya**

Ministry of Economy, Trade and Industry Director, Digital Economy Division



**Mr. Teruyoshi Fujiwara**

Automotive and Battery Traceability Center Association, Inc. (ABtC) Chairperson



**Mr. Lars Bruckner**

Japan Business Council in Europe (JBCE) Vice-Chairman & Member of Board of Directors



Moderator

**Mr. Shozo Maeda**

European Representative, JEITA

October 18<sup>th</sup> Fri

10:30 - 11:30

**Realization of AI Factory ~ Scale-up, scope expansion, and knowledge accumulation****Dr. Hiroaki Kanokogi**

Chief Executive Officer, Yokogawa Digital Corporation

10:30 - 11:30

**The business utilization and social implementation of location data****Mr. Kuni Kawashima**

LBMA Japan

**Mr. Takahiro Yamamoto**

KDDI Corporation

**Mr. Makoto Hasegawa**

SoftBank Corporation

**Mr. Hirokazu Takagi**

NTT Data Corporation

12:00 - 13:00

**Building our future on borderless data-driven collaboration through the Ouranos Ecosystem interoperable data sharing platform initiatives****Mr. Yutaka Saito**

Commissioner, Information-technology Promotion Agency, Japan (IPA)

12:00 - 13:00

**Diversity Team Building to Transform Technology into Economic Value****Dr. Hiroyuki Morikawa**

XG Mobile Promotion Forum co-chairman, Professor, The University of Tokyo

**Ms. Naomi Kamata**

Collective impact leader, ONBOARD

**Ms. Monika Sakuma**

SOMPO Light Vortex

**Ms. Mai Saito**

CEO, Circle of Life

**Mr. Keiichiro Shimada**

Executive Alumnus, Sony

13:30 - 14:30

**Potential of next-generation ocean space utilization  
- Challenging growth markets developed through policy and technology -****Mr. Tadatashi Kaneko**

Cabinet Office, Government of JAPAN National Ocean Policy Secretariat

**Mr. Gen Ooteyamaya**

Japan Underwater Drone Association

**Mr. Satoshi Yoshiga**

FullDepth Co., Ltd.

**Mr. Kai Iwasaki**

The Japan Research Institute

13:30 - 14:30

**What do company leaders think about the present and future of generative AI?****Mr. Tatsu Hayashi**

Stockmark Inc.

**Mr. Norihiko Nakabayashi**

Lion Corporation

**Mr. Hirotaka Ogawa**

AIST Solutions Co.

15:00 - 16:00

**The potential of design to enhance corporate value ~ connecting people, society, and business ~****Mr. Jun Akimoto**

Japan Institute of Design Promotion

**Mr. Yoshifumi Ishikawa**

Canon Inc.

**Ms. Aki Hayash**

Brand Journalism, Inc.

**Mr. Satoshi Sugie**

CEO, Whill Inc.

15:00 - 16:00

**Future Mobility Industry Created by Different Industries with Technologies****Mr. Satoshi Tachibana**

ABeam Consulting Ltd.

**Mr. Takehiro Sato**

SkyDrive Inc.

Results -Exhibitors-

Number of Exhibitors

808 companies /organizations

New Exhibitors

340 companies /organizations

Start up & Universities and Research Organizations

188 companies /organizations

Area	Number of Exhibitors			Number of Booths
	Japan	Overseas	Total	
General Exhibits				
General Exhibits	348	79	427	954
Special Exhibits				
AI for All	25	1	26	84
Partners Park	154	2	156	191
Next Generation Park	121	20	141	162
Global Park	2	56	58	54
Total	650	158	808	1,445

International exhibitors

158 companies /organizations from 25 countries /regions

Europe (15 countries/regions, 24 companies/organizations)

United Kingdom (1), Italy (1), Ukraine (1), Netherlands (2), Greece (1), Spain (1), Slovenia (1), Germany (2), Hungary (1), Finland (1), France (4), Belgium (1), Poland (1), Latvia (5), Serbia (1)

Middle East

(1 country/region 15 companies/organizations)  
United Arab Emirates (15)

Asia

(94 companies/organizations from 7 countries/regions)  
India (3), Korea (2), Singapore (1), Taiwan (47), China (33), Vietnam (1), Hong Kong (7)

North America

(25 companies/organizations from 2 countries/regions)  
United States (19), Canada (6)





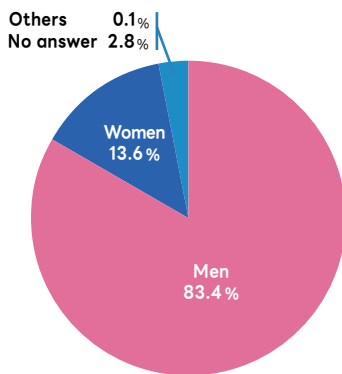
## Number of Visitors

### CEATEC 2024 Visitor Breakdown

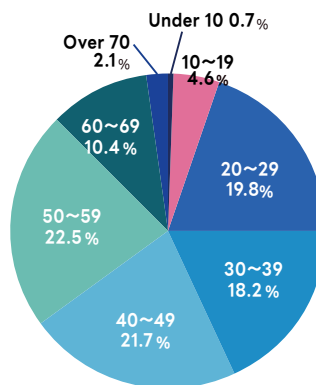
		Oct. 15 (Tue.)	Oct. 16 (Wed.)	Oct. 17 (Thu.)	Oct. 18 (Fri.)	Total
Number of registered visitors	Domestic visitors	14,807	20,907	24,846	30,315	90,875
	Overseas visitors	691	461	389	391	1,932
	subtotal	15,498	21,368	25,235	30,706	92,807
	Press	671	165	126	125	1,087
	Exhibit related	5,228	4,611	4,228	4,053	18,120
	<b>Total</b>	<b>21,397</b>	<b>26,144</b>	<b>29,589</b>	<b>34,884</b>	<b>112,014</b>

### CEATEC 2024 Visitor Attributes \*Note: The total composition ratio (percentage) may not be 100% due to the figures being rounded off.

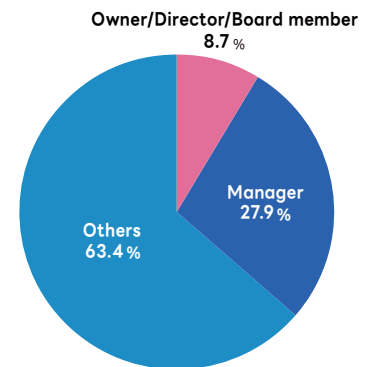
#### Gender



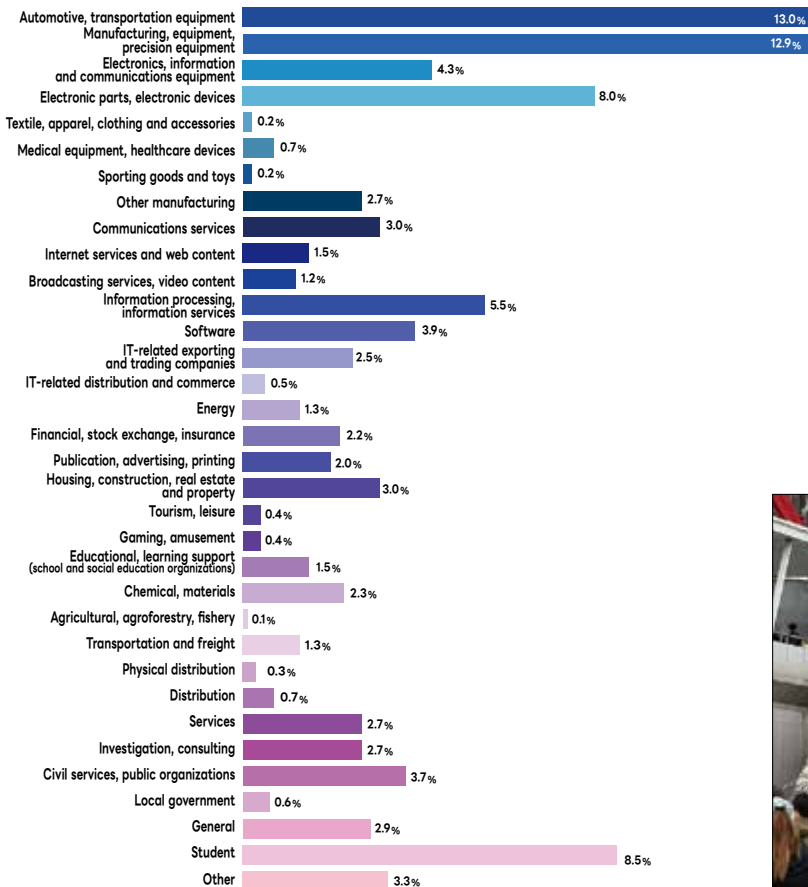
#### Age



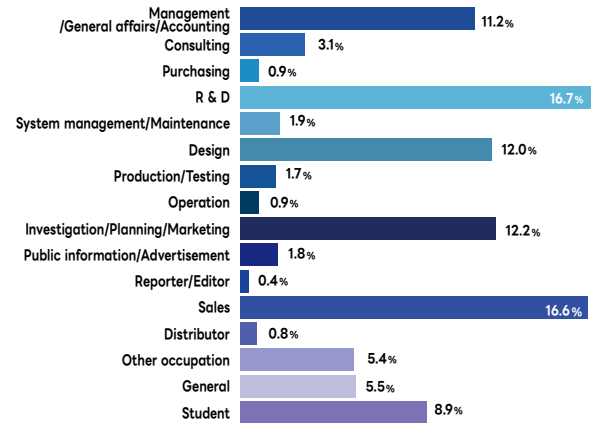
#### Managerial Position



#### Industries

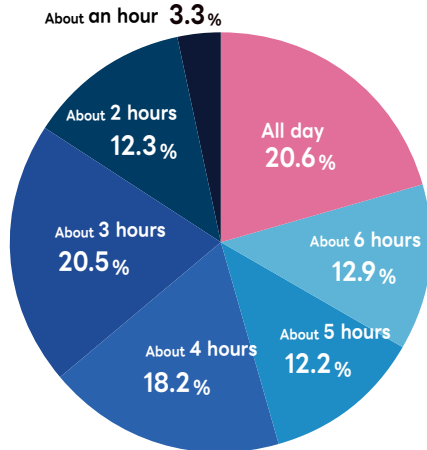


#### Occupations

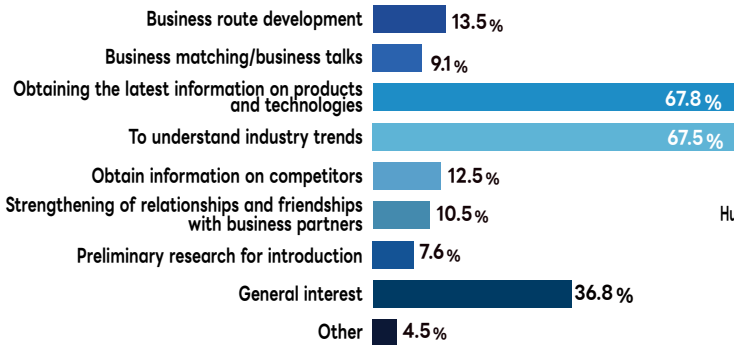


## Visitor Questionnaire

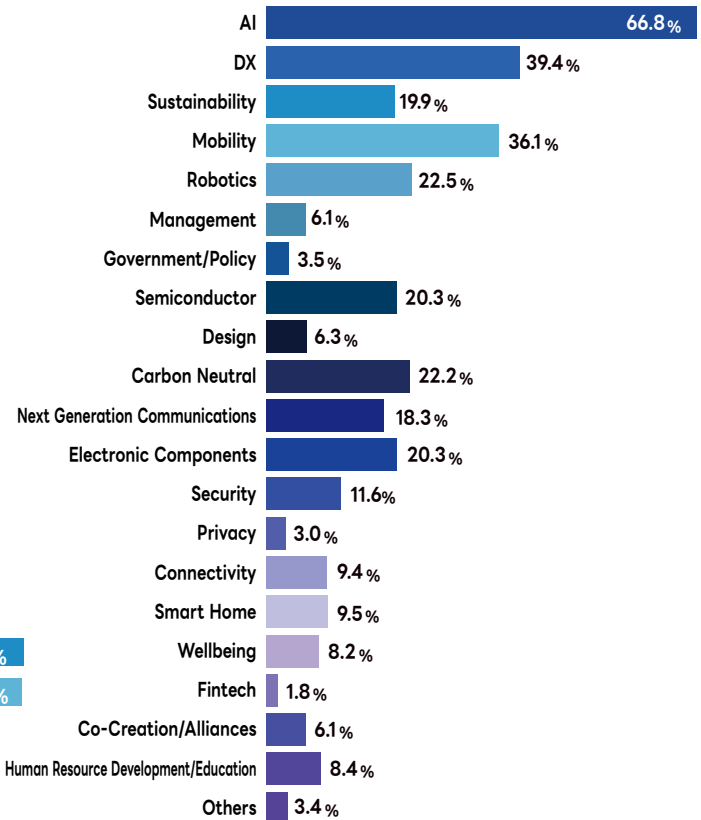
**Q** Please tell us how long you stayed at CEATEC 2024 (Makuhari Messe). If you visited for more than one day, please indicate the time you spent on the day you stayed the longest.



**Q** What was the purpose of your visit to CEATEC 2024? (Multiple responses allowed).

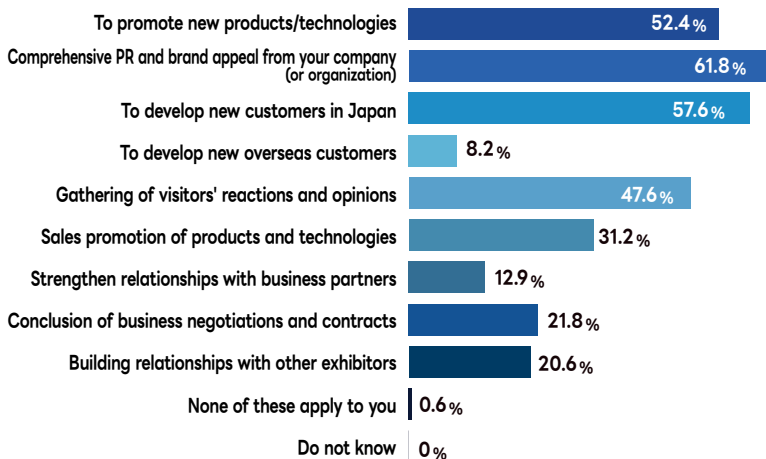


**Q** What keywords attracted your attention at CEATEC 2024? (Multiple responses allowed).

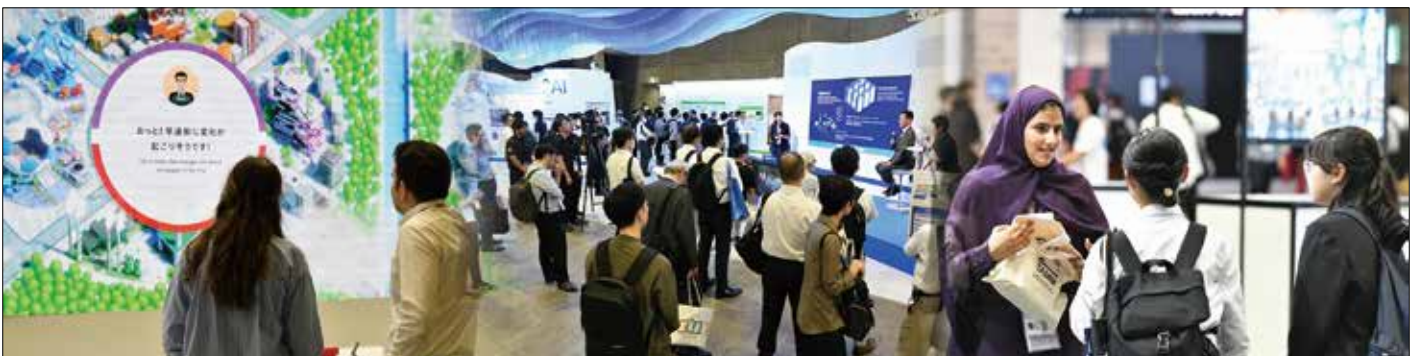
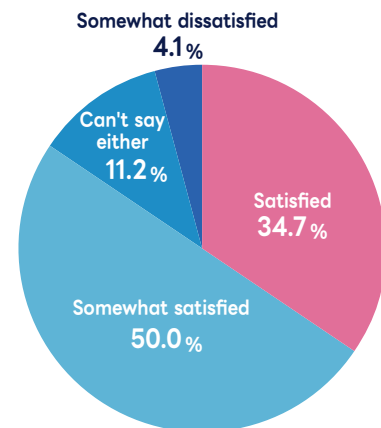


## Exhibitor Questionnaire

**Q** For what purpose did you exhibit?



**Q** Please tell us your overall evaluation of this year's exhibition.



## Public Relations/Promotion

Registered Press:

**1,087** Press members

Digital articles

**6,688**\*Number of articles by Google search  
(CEATEC 2024/News) (as of Nov 24):

Video News (YouTube)

**1,298**\*Number of videos by Google search  
(CEATEC 2024/News/Video) (as of Nov 24)

Newspaper in Japan:

**242** articles

## Pick up &lt;Headline of the news&gt;

Nippon TV News 24 Japan	How will rapidly evolving AI change our lives? "CEATEC 2024"
WION	Innovative Tech On Display At CEATEC 2024   Tech It Out
AP Archive	AI robots you can chat with among trending tech at CEATAC
非凡財經新聞	日本CEATEC展覽開幕! 過半企業都大秀AI技術
Focus全球新聞	CEATEC登場! 聚焦「生活化」AI裝置 OpenAI日本吸睛
Voz de América	CEATEC 2024 en Japón muestra avances de la Inteligencia Artificial: recorrimos la feria tecnológica

TV/ Radio

In Japan:

**39** Programs**2hours, 29Mins, 39seconds in total**Outside  
Japan:**8** Programs**20Mins, 49seconds**

SNS \*2023/11/1 - 2024/10/31

X (Twitter)

Impressions

**5,400,000**

Likes

**17,000**

Video Views

**166,000**

Facebook

Reach

**1,190,000**

Link Clicks

**6,337**

Instagram

Impressions

**4,610,000**

Video Views

**80,000**

Video Watch Time

**260** hours

LinkedIn

Impressions

**1,032,000**

## CEATEC Official Website Results

Measurement period : September 2 - October 31

\*Number of sessions: The number of times a user visits a Web site within a specific period of time.  
\*Reference Source Google Analytics

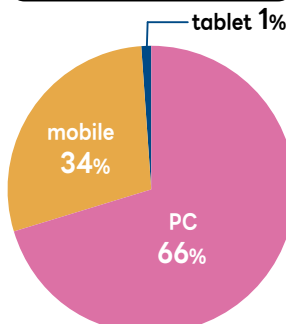
Session:

**876,427** sessions

Number of recipients of official email newsletters :

**370,000+**In Japan : **360,000+**  
Outside Japan: **10,000**

Web access by device



Web access by nation (sessions)

Japan	<b>837,138</b>
United States	<b>14,785</b>
Taiwan	<b>5,206</b>
Korea	<b>3,454</b>
China	<b>2,572</b>
United Kingdom	<b>1,450</b>
Singapore	<b>1,643</b>
Germany	<b>1,010</b>
Hong Kong	<b>1,181</b>
India	<b>998</b>

#### Organizer

**JEITA** Japan Electronics and Information Technology Industries Association

#### Co-sponsors

**CIAJ** Communications and Information Network Association of Japan

 Software Association of Japan

#### Contact Us

CEATEC Management Office  
(Japan Electronics Show Association (JESA))